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Case Docket No. 0885-CS

Sir:

Transmitted herewith for filing is the patent application of

INVENTOR: Joel PAGE, Edwin De ANGEL, Wai Laing LEE, Lei WANG,
Hong ZHENG and Chung-Kai CHOW

FOR: POWER ON RESET TECHNIQUES FOR AN INTEGRATED CIRCUIT CHIP

Enclosed are:

- [X] 58 pages of cover sheet, specification, appendices, claims, and abstract
- [] Declaration & Power of Attorney
- [] Priority Claim
- [] Certified copy of _____
- [X] 35 sheets of formal drawing
- [] An assignment of the invention to _____ and the assignment recordation fee
- [X] Return Receipt Postcard
- [] Information Disclosure Statement, Form PTO-1449
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CIRRUS LOGIC INC.
Intellectual Property/Legal Department
3100 West Warren Avenue
MS-521
Fremont, CA 94538-6419

McDERMOTT, WILL & EMERY

David L. Stewart
Registration No. 37,578
99 Canal Center Plaza, Suite 300
Alexandria, Virginia 22314
(202) 756-8000 DLS:llm

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50246-040

POWER ON RESET TECHNIQUES FOR AN
INTEGRATED CIRCUIT CHIP

Inventors:

Joel Page
16 Laurel Hill
Austin, TX 78737

Citizenship: USA

Edwin De Angel
5357 Austral Loop
Austin, TX 78739

Citizenship: USA

Wai Laing Lee
5706 Eallenton Court
Austin, TX 78739

Citizenship: USA

Lei Wang
3111 Parker Lane, #159
Austin, TX 78741

Citizenship: China

Hong Zheng
58 Austin
Irvine, CA 97604

Citizenship: Peoples' Republic
of China

Chung-Kai Chow
7436 Lady Suzannes Court
Austin, TX 78729

Citizenship: British-Hong Kong

POWER ON RESET TECHNIQUES FOR AN
INTEGRATED CIRCUIT CHIP

CROSS-REFERENCES TO RELATED APPLICATIONS

The invention disclosed herein is related to Application Serial Number _____, Docket No. 0877-CS (50246-032/3171-021) filed _____, by inventors
5 Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong Zheng and Chung-Kai Chow and entitled "A POLYPHASE FILTER FOR SELECTIVE PHASE SHIFTING."

The invention disclosed herein is related to Application Serial Number _____, Docket No. 0878-CS
10 (50246-033/3171-022) filed _____, by inventors Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong Zheng and Chung-Kai Chow and entitled "A SINC FILTER WITH SELECTIVE DECIMATION RATIOS."

The invention disclosed herein is related to Application Serial Number _____, Docket No. 0879-CS
15 (50246-034/3171-023) filed _____, by inventors Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong Zheng and Chung-Kai Chow and entitled "A SINC FILTER USING TWISTING SYMMETRY."

The invention disclosed herein is related to Application Serial Number _____, Docket No. 0880-CS
20 (50246-035/3171-024) filed _____, by inventors Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong Zheng and Chung-Kai Chow and entitled "A LINEAR PHASE FIR SINC FILTER WITH MULTIPLEXING."

The invention disclosed herein is related to Application Serial Number _____, Docket No. 0881-CS
25 (50246-036/3171-025) filed _____, by inventors Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong Zheng,
30 Chung-Kai Chow and entitled "NETWORK SYNCHRONIZATION."

5 The invention disclosed herein is related to
Application Serial Number _____, Docket No. 0882-CS
(50246-037/3171-026) filed _____, by inventors
Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong
Zheng and Chung-Kai Chow and entitled "CLOCK ALIGNMENT
FOR REDUCED NOISE AND EASY INTERFACING."

10 The invention disclosed herein is related to
Application Serial Number _____, Docket No. 0883-CS
(50246-038/3171-027) filed _____, by inventors
Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong
Zheng and Chung-Kai Chow and entitled "A CHIP
ARCHITECTURE FOR DATA ACQUISITION."

15 The invention disclosed herein is related to
Application Serial Number _____, Docket No. 0884-CS
(50246-049/3171-028) filed _____, by inventors
Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong
Zheng and Chung-Kai Chow and entitled "SYSTEM AND
TECHNIQUES FOR SEISMIC DATA ACQUISITION."

20 The invention disclosed herein is related to
Application Serial Number _____, Docket No. 0886-CS
(50246-041/3171-030) filed _____, by inventors
Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong
Zheng and Chung-Kai Chow and entitled "NOISE MANAGEMENT
USING A SWITCHED CONVERTER."

25 The invention disclosed herein is related to
Application Serial Number _____, Docket No. 0887-CS
(50246-042/3171-031) filed _____, by inventors
Joel Page, Edwin De Angel, Wai Laing Lee, Lei Wang, Hong
Zheng and Chung-Kai Chow and entitled "CORRECT CARRY BIT
30 GENERATION."

BACKGROUND OF THE INVENTION

Field of the Invention

The invention is directed to power circuits for
integrated circuits and, more particularly, to a power on

reset circuit which inhibits operation until voltage stability is achieved.

DESCRIPTION OF RELATED ART

Systems for conducting seismic exploration are well known in the art. On land, a plurality of transducers are deployed over a region and configured to receive reflections of acoustic signals from different geophysical layers beneath the surface of the earth. Seismic sensors are connected over cables to signal conditioning, digitization and digital recording equipment. When utilizing a seismic system, a strong acoustic signal is generated by, for example, setting off an explosion or by utilizing an acoustic signal generator having a relatively high power output. Reflections of the acoustic signals from the geophysical layers are then received at the seismic sensors deployed over a given area and the signals recorded, typically, for later analysis.

One problem with seismic exploration is that it frequently occurs in remote areas. Once sensors are deployed over a large area and seismic data gathered, great expense would be incurred if data were corrupted by malfunctioning sensors or electronics and a seismic survey crew needed to return again to the site, set up equipment and re-gather the data.

Seismic exploration has exacting requirements for seismic sensors and for the electronics which processes the signals derived from seismic sensors. There is therefore a need to be able to test both the sensors and related equipment to ensure that both the devices and the associated electronics are functioning properly. It is important that the seismic data gathering equipment be able to synchronize the data gathered with the explosion used for a measurement. This is somewhat difficult when the timing of the explosion with respect

to the triggering signal is unpredictable, as it is with, for example, dynamite.

SUMMARY OF THE INVENTION

5 The invention is directed to a power on reset circuit, preferably for an integrated circuit, which detects application of voltage, starts a phase locked loop once application of voltage is detected but inhibits all clock used for digital logic operations until voltage stability is achieved. If a switched converter is used, 10 the duty cycle of the switched converter is held at unity for a period of time before it is set to that needed to achieve the desired chip operating voltage. Clocks controlling other circuits can be released in stages after the duty cycle of the switched converter is set to 15 its operating voltage level.

BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 is a block diagram of a network used to collect data from a plurality of seismic sensors in accordance with the invention.

20 Figure 2 is a block diagram showing interconnection of a plurality of remote sensing units in a network configuration permitting high data reliability.

Figure 3A is a diagram showing the transmission format utilized on the command link shown in Figure 2.

25 Figure 3B is a diagram showing the transmission format on the data links shown in Figure 2.

Figure 3C is a diagram showing an exemplary arrangement of a command frame format in accordance with the invention.

30 Figure 3D is a diagram showing an exemplary data frame format utilized in accordance with the invention.

Figure 4 is a diagram showing how round trip delay time is measured for a remote station unit.

Figure 5 is a diagram showing data shift resulting from round trip delay.

Figure 6A is an illustration used for explaining network synchronization.

5 Figure 6B shows synchronization sequences and how network synchronization

Figure 7 is a block diagram showing chip pin connections and functional blocks of a RSU shown in Figure 1.

10 Figure 8 is a block diagram showing signal processing of a seismic sensor output at a high level.

Figure 9 is a block diagram showing a prior art approach to implementing the processing shown in Figure 8.

15 Figure 10 is a block diagram showing an improved approach to seismic processing utilizing a polyphase filter in accordance with the invention.

Figure 11 shows an improved version of the polyphase filter utilizing cascaded polyphase filters.

20 Figure 12 is a graph showing the response of two members of a set of polyphase filters.

Figures 13-1A through 13-1C, Figures 13-2A through 13-2C and 13-3A through 13-3C show relative coefficients, response and transform representations of response of first order, second order and third order sinc filters, respectively.

25 Figure 14 is a block diagram showing a linear phase FIR sinc filter implementation with selectably variable decimations factors.

30 Figure 15 is a diagram illustrating the principles of operation of sinc filter number 1 shown in Figure 14.

Figure 16 is a block diagram showing functionally how the data illustrated in Figure 15 are processed in an exemplary implementation.

35 Figures 17A and 17B together illustrate hardware preferably utilized to implement the sinc filter

Sinc#1 shown in Figure 14.

Figure 18A symbolically illustrates the operations of shifting and addition utilized in carrying out implementation of sinc filters sinc#2 shown in Figure 14.

5 Figures 18B-1 through 18B-4 show the mathematics for a similar implementation for each of sinc filters sinc#3 through sinc#5.

10 Figures 19A is a block diagram of a single-control, multiple datapath architecture utilized in implementing sinc filters sinc#2 through sinc#5 of Figure 14.

Figure 19B shows programming or logic used in item 1910 of Figure 19A.

15 Figure 20 is a block diagram showing how a linear phase FIR sinc filter can be improved by decomposition of the calculations into two stages.

Figure 21A illustrates a factor of eight decimation such as might be utilized in one configuration of the circuitry of Figure 14.

20 Figure 21B shows the calculations required to carry out the factor of eight decimation shown in Figure 21A.

Figure 21C shows an improved allocation of calculations resulting from the decomposition of FIR processing into two stages as discussed in conjunction with Figure 20.

25 Figure 21D shows a further improvement in processing allocation resulting from equalization of calculation across sampling instances.

Figure 22 shows a switched power converter of a type known in the prior art.

30 Figure 23 shows an improved switched power converter in accordance with the invention.

Figure 24 is a schematic diagram of an exemplary break before make circuit of figure 23.

35 Figure 25 is a timing diagram showing a protocol suitable for use during power on reset when using a switched converter power source.

Figure 26 is a timing diagram showing a protocol suitable for user during power on reset when using a regulator power source.

Figure 27 is a flow chart of a process used during power on reset of a power source.

Figure 28 shows a plurality of time lines showing clock alignment associated with on-chip generation of clocks in accordance with the invention.

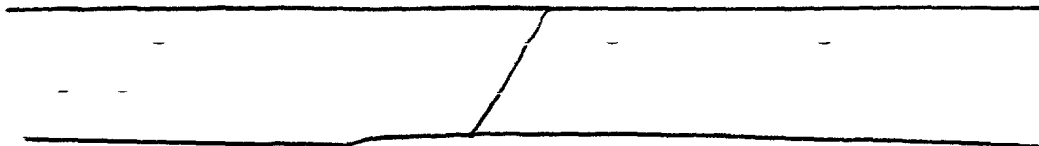


Figure 29 is a flow chart of a process for programming clocks in accordance with the invention.

Figure 30 is a mathematical relationship showing how a multiply and add operation using rounding is implemented.

Figure 31 illustrates how the equation of Figure 30 would be implemented, in block form.

Figure 32 is a block diagram showing the logic of how the multiply and add result of Figure 31 is utilized for proper care detection.

Figure 33 is a logic diagram showing the implementation of carry detect circuit 3240 shown in block form in Figure 32.

DESCRIPTION OF THE INVENTION

Figure 1 is a block diagram of a network used to collect data from a plurality of seismic sensors in accordance with the invention. A plurality of seismic sensors 100 are distributed over a large area. Each seismic sensor connects to a respective analog to digital converter (ADC) interface 110. The ADC interface 110 converts the analog output of its seismic sensor into a digital stream for application to a network interface referred to herein as a RSU (RSU) 120. The ADC interface can, of course, be designed to accommodate more than one

RSU. RSU 120 is, preferably, an integrated circuit chip designed for low power consumption and shown more particularly in Figure 7. RSUs 120 are connected to a digital telemetry cable 130 as shown more in detail in Figure 2. A slave line control unit (SLCU) 140 interfaces digital telemetry cables 130 to a 32 Mbps line 150. The SLCU is similar to RSU 120 except configured to operate in a master mode. SLCU 140 sends information from a digital telemetry cable(s) which it services to the central processing and recording unit and passes information from the central processing and recording unit to the RSUs on the digital telemetry cable 130. The central processing and recording unit 160 collects the data from the sensors for geophysical analysis in a manner known in the art.

Figure 2 is a block diagram showing a preferred interconnection of a plurality of remote sensing units (RSUs) in a network configuration permitting high data reliability. Other network configurations are, of course, possible. The figure shows a plurality of redundant lines comprising digital telemetry cable 130. A command line or command link 200 connects to each of the RSUs as described more hereinafter. Each RSU 120 connects to each adjacent neighbor over links such as 210 and 220 shown in Figure 2. The remote sensing unit also connects to each next adjacent neighbor over links such as links 230 and 240 shown in Figure 2. In a preferred embodiment, the remote sensing unit has 4 data ports, each bidirectional in nature, and which permits a robustness of interconnection ensuring high reliability in the return of data from the seismic sensors over the digital telemetry cable 130. The particular data ports at the remote sensing unit 120 utilized for the data link return of information from the seismic sensors to the central processing and recording unit can be specified by

the central processing and recording unit 160 as described more hereinafter.

5 The central processing and recording unit 160 sends commands to individual RSUs (RSU), groups of RSUs or to all RSUs over the command line. The command line utilizes two wire differential Manchester encoding and each RSU utilizes a phase lock loop to effectuate clock recovery from the incoming command line data. In a preferred implementation, the PLL clock recovery locks at
10 a clock rate 16 times the line rate of the command line.

15 The network shown in Figure 1 operates normally in a poll-select mode. The central processing and recording unit operates as a network master station which continuously polls one or more RSUs on an ongoing basis. When a station is polled and has information to send to the central, it returns a flag or a flag and data indicating that data is to be sent or is sent concurrently. When the RSU is selected for data transmission (i.e. authorized to transmit data by the
20 central), the RSU sends data back over the data link. The particular port utilized to send the data has been previously set by the central processing and recording unit by information transmitted over the command line. Thus, the central processing and recording unit controls
25 the individual ports utilized in each RSU and thus defines the data ports in use at each RSU for the return data link.

Figure 3A is a diagram showing the transmission format utilized on the command link shown in Figure 2.
30 The central processing and recording unit 160 sends a continuous stream of command frames over the command link as illustrated in Figure 3.

35 Due to the nature of the data link, the slave nodes have always access to the data link. Setting of the slave nodes into a transmit or into a repeat mode on the data link is controlled by the master node. The master

is usually only listening to the data link. The slave nodes transmit seismic data frames, status frames and auxiliary frames to the master node on the data link.

Figure 3B is a diagram showing the transmission format on the data links shown in Figure 2. A plurality of data frames 400 are transmitted repeatedly on the data link. Each data frame is separated from an adjacent data frame by zero or more idle slots. The actual number of idle slots employed between data frames is determined by the distance between nodes. The number of idle slots is utilized to ensure that there will be no collisions due to propagation delays on the link.

The data link may be operated selectively in a high rate mode and in a low rate mode. The RSU may operate in a number of operational modes. In a booting mode, a number of data links and command link transmission parameters are determined (e.g bit synchronization, frame synchronization), node configuration, etc. Every node/channel is assigned a logical network address during the booting mode.

In an initialization mode, the application modules in the RSU will be programmed through the telemetry interface (TMI). This involves downloading of control register values, the setting of program and coefficients for the digital signal processor and auxiliary nodes.

In an acquisition mode, a continuous poll/configuration/NOP command bit stream is received and a seismic/status/auxiliary word bit stream is transmitted to the slave line control unit 140 for passing to the central processing and recording unit 160.

The RSU can be set in a command loop back mode which is used for the measurement of node distances from the central. In the loop back mode, the received command bit stream will be looped back and transmitted on the data link back to the central. This can be optionally done

with scrambling and descrambling to achieve desired spectral characteristics.

In a diagnostic node, the RSU can be utilized for detection of data links having degraded bit error rate performance. In this mode, the last node on a line is programmed to transmit a downloaded diagnostic pattern continuously and all other nodes detect the occurrence of the diagnostic (unique) pattern in the repeated bit stream. This, too, may be selectively scrambled.

Each RSU may operate in an SPI master mode in which it serves as a master node for a serial peripheral interface (SPI) bus. Alternatively, the RSU may operate in a SPI slave mode.

In a test mode, the internal telemetry functionality will be verified by running a test procedure from the central processing and recording unit operating as a system network controller.

Figure 3C is a diagram showing an exemplary arrangement of a command frame format in accordance with the invention. The command frame format utilized on the command link begins with a frame sync pattern 500. A poll command 510 and a poll address 520 are utilized to specify the type of poll and the address of the station(s) designated to respond. The configuration address 530 and configuration command 540 together with parameters 550 are utilized to set configuration at one or more RSUs. The TSG data 560 is utilized to send information for driving a test signal generator in the RSU. The frame ends with a frame check sequence 570, preferably using a cyclic redundancy code (CRC) check sum.

Figure 3D is a diagram showing an exemplary data frame format utilized in accordance with the invention. The seismic data frame has a fixed length of 448 bits, configured as follows: The frame begins with a scrambling initiation pattern 600. It is followed by a frame sync

pattern 610 indicating the start of data. The source address 620 identifies the RSU and, if more than one channel is utilized on the RSU, the channel which is the source of the data. A particular type of data frame can be specified in fields 630. A time tag 640 permits certain timing adjustments to be made. A plurality of seismic samples 650 then follow. Certain status flags can be sent in field 660. The seismic data frame ends with a CRC frame check sequence 670.

On the command link, frame synchronization is based on transmission of an eight bit long frame sync bit pattern in every transmitted command frame. The sync pattern alternates between a pattern A and a pattern B in consecutive command frames. Pattern A is the inverse of pattern B. A rest command occurs after command number 73 in the polling sequence and contains two C patterns which are used for detection of the remainder in the polling period.

There is no separate frame synchronization procedure for the data link transmission in the RSUs. The data link transmission are phase locked to the command link transmission.

The addresses for the individual RSUs are assigned by the master unit as a function of distance and polling occurs in address sequence, beginning with the closest RSU.

Figure 4 is a diagram showing how round trip delay time is measured for a remote station unit. There are two major adjustments used in synchronizing the network. One adjusts for round trip delay. The other adjusts the timing of data gathering.

When adjusting for round trip delay, the central stations 400 places a particular RSU into a loop-back mode and sends a bit pattern, such as 0110100 over the command link. In an exemplary embodiment, the data link is operated at 4 times the rate of the command link.

Since the clocks are synchronized, one bit from the command link will be sampled four times for transmission over the data link.

Figure 5 is a diagram showing data shift resulting from round trip delay. In the example shown in Figure 5, the loop backed version of the sampled synchronization pattern is compared in phase with the expected return signal. In the example shown in Figure 5, two clock units of delay are experienced during the round trip. A single unit of delay added to the path will be traversed twice, once in the outgoing and once in the return direction, thus equalizing the delay to what it should be.

Figure 6A is an illustration used for explaining network synchronization. A free running counter 600 runs at an exemplary 4 MHz rate. It is reset upon the first CCA or CCB pattern which occurs after a SYNC signal. The latch contains the selected CCA or CCB pattern. If a SYNC signal isn't received, nothing happens. When the next SYNC signal is actually received, the counter is reset and the amount of any error can be determined. These relationships are illustrated in Figure 6B.

Figure 7 is a block diagram showing chip pin connections and functional blocks of an RSU shown in Figure 1. As shown in Figure 7, the command link receiver 715 connects to and receives commands over the command link 200. A set of buffered outputs are available for external use. The command link receiver passes commands to command decoder 720 where the commands are decoded or interpreted and appropriate commands and data sent over bus 700 to the various connected devices shown in Figure 7 as functional blocks connected to the bus.

This chip shown in Figure 7 also includes a separate digital signal processor (DSP) data bus 705. This bus is utilized in connection with the processing of signals

received from ADC interface 110 over inputs MDATA[1],
MDATA[2] and MDATA[3]. Certain portions of the data
filtering discussed hereinafter occur in modulator data
interface 730 with the remainder executed in the digital
5 signal processor 735. The allocation described
hereinafter is preferred, but other allocations are
possible. When the processing of the incoming digital
signals is completed by the Modulator Bus Interface and
the DSP and it is desired to transmit the data to the
10 central processing and recording unit 160, the data is
applied through data FIFO 740 to data transceiver 745.
The data transceivers 745 include four ports referred to
generally as DATAA, DATAB, DATAC and DATAD in Figure 7.
Those four ports are utilized to achieve the network
conductivity described in conjunction with Figure 2.

General purpose I/O (GPIO) 750 can be used to pass
signals to one or more attached devices, such as passing
control signals to ADC interface 110. The serial
peripheral interface 755 can likewise be utilized to
20 communicate with external peripherals and, in one
application, can be utilized to upload code to
programmable devices on the ADC interface 110.

The regulator/SC converter 770 is utilized to
provide a programmable DC-DC converter to permit
selective voltage levels to be generated for the chip.
25 This is discussed more hereinafter.

The TSG buffer and filter 760 is utilized to send
test signal data to the ADC interface 110 for testing
purposes.

30 The scratch pad memory 780 is utilized for
calculations on an as needed basis. The watch dog timer
790 ensures that the DSP data bus 705 does not hang up
without being noticed.

As part of the bootup/initialization of the network,
35 the central processing and recording unit 160 broadcasts
a rough delay value to all RSUs. That value is the same

for all RSUs and is stored in a register within the chip 120 for delay equalization purposes. After that is done, the central processing and recording unit 160 polls each of the individual RSUs, one at a time, sends a loop back command to the RSU to cause the data received over the command link to be looped back over one of the data links to the central processing and recording unit 160, thus permitting the central processing and recording unit 160 to measure the round trip delay from the central to the RSU and back. Once the amount of delay is determined based on the round trip delay, the central processing and recording unit 160 will load a register of the individual RSU with a fine delay value to be used for correcting for differences in delay. The amount of fine adjustment loaded in each RSU is different and is based on the described measurement of the round trip delay time. The goal is to have all nodes sampling at the same point in absolute time so that data received at the central processing and recording unit from each of the nodes will have the same time base.

Figure 8 is a block diagram showing at a high level signal processing of a seismic sensor output. The analog signal from seismic sensors 100 is passed through ADC interface 110 to certain decimation filtering implemented on RSU 120 as described more hereinafter and then through to the central processing and recording unit 160. In a preferred embodiment, it is received from the ADC interface 110 as 512 kHz, 1 bit delta-sigma data. The decimation on RSU 120 converts the one bit delta-sigma modulated data into 24 bit sample data having a recurrence rate ranging between 250 Hz and 4 KHz depending upon the settings of the decimation filter. This filtering will be discussed more hereinafter.

When the arrangement shown in Figure 8 is utilized, there is a problem. The acoustic source utilized to gather seismic data is not synchronized with the seismic

data acquisition system clock. This is particularly true when dynamite is utilized as the source of the acoustic impulse. Even if the triggering signal for the dynamite is synchronized with the seismic data acquisition system clock, there is an uncertain delay from the application of the triggering signal to the actual detonation of the dynamite. As a result, it is necessary to realign all channels of data in the time domain based on the actual detonation point. For a 512 kHz 1-bit sample rate, the decimated output data rate is only 1.0 kHz, but the time resolution of synchronization is required to be 4.0 microseconds or less. There are a number of sources of delay from the shooting time to the time of receiving data from all channels. The delay includes the network propagation delay, discussed above, and filter calculation delay.

Figure 9 is a block diagram showing a prior art approach to solving the problem discussed in conjunction with Figure 8. In the prior art, to achieve that synchronization, the one bit signal from the ADC interface 110 was applied to a data RAM buffer 900 and stored there until a synchronization signal was received from control logic 910 indicating that the shot had occurred. The data samples were then read beginning with a point in the data RAM buffer which corresponded to the needed amount of delay to synchronize the data with the shot. Once that point was identified, data was passed to a digital processing chip. There variable decimation filtering would occur resulting in an N-bit 1.0 kHz output signal.

The approach shown in Figure 9 has several disadvantages. First a long systematic delay requires a large amount of storage, so much so that an additional RAM chip is required before decimation in order to store the data after the shot at the resolution of the sampling rate. That increases expense and reduces reliability.

There is also a need for extra control logic. For example, at a 512 kHz sample rate, for each data conversion channel, a systematic delay of 50 milliseconds (typical) needs a RAM size of 25.6 kilobits. If the chip shown in Figure 7 handles three data conversion channels as the chip shown in Figure 7 does, it would require 76.8 kilobits of storage.

Figure 10 is a block diagram showing an improved approach to seismic processing utilizing a polyphase filter in accordance with the invention. After decimation filtering 920, a polyphase all-pass linear phase FIR filter is implemented and does the selective phase adjustment needed to bring the data into alignment with a shot. In this case, the all pass linear phase FIR filter adds a group delay of $(N-1)*4.0$ microseconds. By storing and selecting a number of filter parameter sets, N different all-pass filters can be selectively implemented resulting in a polyphase filter or phase shifter. Each set of coefficients provides a group delay of $i*4.0$ microseconds, where $i = 0, 1, 2, \dots, N-1$.

If the output rate is 1.024 KHz and the synchronization resolution required is 4.0 microseconds, then one could implement selective delays between 0 and 50 msec at 4 μ sec resolution by using a group polyphase filter with 256 sets of coefficients. The particular set of coefficients selected to add a group delay to the output data depending on the time of occurrence of the shot. Thus, each set of filter coefficients can implement a phase shifter having a discrete group delay of $i*4\mu$ sec, where $i=0, 1, 2, \dots, 255$.

When the central processing and recording unit 160 detects a shot, it sends a command (e.g. broadcast) specifying a time value for the shot. The time value can be established, for example, by detecting the explosion at the central processing and recording unit or by adding a known delay from the triggering instant. Upon receipt

of that command, the amount of shift required to adjust the phase of the sampling to the timing of the shot is determined and a filter coefficient set is selected to impart the appropriate group delay to the polyphase all-pass linear phase FIR filter 1000. The polyphase filter thus makes the timing adjustment needed to synchronize with the shot. Thus, the phase adjustment imposed by the polyphase all-pass linear phase FIR filter 1000 varies from shot to shot and ensures that the data is synchronized with the shot. Further, since the decimation filtering process 920 removes the HF noise and lowers the data rate, very little storage is required.

In an exemplary implementation, a 256:1 decimation filter can be utilized with a sampling frequency F_s of 256 kHz with N_{tot} taps. The coefficients of the filter can be decimated by the ratio 256 by picking up coefficients every 256 points. The coefficient of one set of polyphase filter is formed and the number of its taps is $N_{tot}/256$. There are thus totally 256 different sets of $N_{tot}/256$ -tap linear phase FIR filters obtained from the decimation filter, each having a data rate equaling 1.0 kHz. Each set has a group delay difference of 4.0 microseconds from its adjacent sets of filter coefficients. Thus a phase shifter can be described as $h_{p(ij)} = h_{(j-1)} * 256 + i$, where i equals an integer from 1 to 256 and represents a number of the set and where j is a number from 1 to $N_{tot}/256$ which represents the numbering of the coefficients.

The coefficients for the i th set of coefficients for a polyphase filter are inversely symmetrical to the $(256-i)$ th set of coefficients. Thus, the storage required to store the coefficients for the polyphase filter can be reduced by a factor of 2 by taking advantage of that symmetry.

Figure 11 shows an improved version of the polyphase filter which utilizes cascaded polyphase filters.

Several benefits can be achieved from splitting a polyphase filter into two polyphase filters. First the calculations needed for the cascade filter is about the same as the single stage polyphase filter but a reduced number of taps is required. In the example discussed in conjunction with Figure 11, the polyphase filter 1 utilizes 16 sets of coefficients, each one differing from an adjacent set of coefficients by 64 μ sec. Polyphase filter 2 then provides for 4 μ sec resolution within the 64 μ sec windows provided by polyphase filter 1. Thus, only 32 sets of coefficients are required in order to specify the 256 4 μ sec windows required to achieve the resolution needed to synchronize with the shot over a 50msec interval. If a single stage polyphase filter were utilized, then 256 sets of coefficients would be required. Thus, the coefficient storage requirements for the polyphase filter are reduced considerably by dividing the polyphase filter into two polyphase filters. Also, each set of cascade polyphase filter coefficients is shorter than a set of single stage polyphase filter. Even if a cascade calculation of two filters is needed, the total calculation amount is about the same as needed in the single stage polyphase filter.

Additionally, using a 2 stage polyphase filter, there is an ease of addressing associated with the selection of the overall delay required for synchronization to the shot. The amount of delay can be specified as a single byte with the 4 most significant bits specifying which of the 64 microsecond windows should be established by polyphase filter 1 and the least significant bits specifying the 4 microsecond window within the 64 microsecond window required to synchronize with the shot. Thus, a single word can be utilized to select the coefficients for both polyphase filter 1 and polyphase filter 2.

Figure 12 is a graph showing the response of two members of a set of polyphase filters. Figure 12 shows two curves reflecting the response of a polyphase filter, each curve representing the response for a respective set of coefficients. In essence, the response is substantially identical but shifted in phase by a fraction of a sampling interval.

The polyphase filter described herein is much better than prior art techniques because the polyphase filter can be implemented on the digital chip resulting in the elimination of the extra RAM chip and its corresponding cost and reliability problems. It is suitable for use in any case where real-time high resolution synchronization is required and it reduces ROM and calculation power needed over that required by the prior art.

In the chip architecture shown in Figure 7, the polyphase filter and linear phase FIR filter and a IIR filter are implemented using the digital signal processor 735.

An exemplary set of coefficients for polyphase filter 1 is set forth in Appendix A. An exemplary set of coefficients for polyphase filter 2 is set forth in Appendix B.

Figures 13-1A through 13-1C, Figures 13-2A through 13-2C and 13-3A through 13-3C show sample weighing (coefficient values, response and transform representations of response of first order, second order and third order sinc filters respectively.

The decimation filtering 920 shown in Figure 10 includes a sinc filter which receives the output of the ADC conversion accomplished by ADC interface 110. The sinc filters of the prior art consume more power than was desirable for the low power implementation of the invention. Sinc decimation filters are preferably used because they have well behaved transfer functions and high attenuation at the alias frequencies. In the time

domain, they have relatively few taps and use small integer coefficients. A sinc filter can be realized in at least two ways. In one form, a sinc filter can be expressed as a cascade integrate-comb (CIC) filter. Such a filter has the following transfer function:

$$H(Z) = \frac{(1-Z^{-R})^N}{(1-Z^{-1})^N}$$

(Equation 1)

where R is the decimation ratio and N is the order of the filter. This can be realized as a combination of integrators and differentiators.

Alternatively, a sinc filter can be expressed as a linear phase FIR filter. In this case:

$$y(n) = h_0 \cdot x(n) + h_1 \cdot x(n-1) + \dots + h_{m-1} \cdot x(n-m+1)$$

(Equation 2)

where M is equal to the number of taps and where the taps are symmetric.

A CIC sinc filter implementation can be constructed of integrators and differentiators in either a direct or cascade structure. While the CIC implementation uses only additions and permits easy achievement of variable decimation ratios, it uses considerable power and is therefore not suitable for low power filter design. In addition, the accumulator length grows very fast with filter order and decimation ratio which in turn also increases power consumption.

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An linear phase FIR sinc filter implementation, on the other hand, has more complicated hardware requirements and more complicated operating sequences and would not likely normally be chosen for an IC design, but, in this implementation, it has the advantage that power savings can be achieved since (1) the quantities of computation required are decreased, (2) the register length can be kept at 24 bits or less, (3) one bit inputs permit table lookup of coefficients, (4) the coefficients are small and integer and (5) the filter can be implemented with shifts and additions.

Figure 14 is a block diagram showing a linear phase FIR sinc filter implementation with variable decimation factors. Variable order decimation in accordance with the invention can be achieved by switching in or out, selectively, a plurality of sinc decimation filters. A two stage decimation process is illustrated. The first stage, in a preferred embodiment, includes a fifth order, 36 tap linear phase FIR sinc filter used to decimate a 1 bit 512 kHz input by a factor of 8 to a 64 kHz 17 bit input. The output of the first stage sinc filter is applied to a pipe line arrangement of sinc filters which can be selectively activated in sequence to achieve desired decimation ratios. In the examples shown, decimation ratios of 16, 32, 64, 96 and 128 can be selected. Other arrangements can be implemented to achieve different ratios as desired. The sinc 1 linear phase FIR filter implementation has the advantage that it can be implemented with lookup tables and additions (see equation 2). The tables are small enough for direct implementation because the filter coefficients are symmetrical and because partial results are anti-symmetric for one bit inputs. Using these symmetries, one can reduce the ROM size required to about 25% of what would otherwise have been required.

Figure 15 is a diagram illustrating the principles of operation of sinc filter sinc#1 shown in Figure 14. The 512 kHz one bit input to the sinc 1 first stage input is fed into a serial register 1500. There is a central line 1510 which forms an axis of symmetry for analysis purposes. On either side of the symmetry line, 8 bit words are defined, namely word#1, word#2, word#3 and word#4 as shown in the figure. In this implementation, the register is 36 bits long. As a result, two bits, namely X_0 and X_{-1} are left over on the left edge of the register. These bits will be referred to as the "head" bits. In addition, two bits are left over at the right extreme of the register, namely bits X_{-34} and X_{-35} . These two bits are referred to as the "tail" bits. When multiplied by respective coefficients H_i each of the bits in the register form an output.

Figure 16 is a block diagram showing how the data discussed in conjunction with Figure 15 are processed in an exemplary implementation. In Figure 16, a convenient way of multiplying the incoming bits by the coefficients of the sinc filter is shown. A plurality of lookup tables 1600, 1610 and 1620 (implemented either as ROM or logic) are utilized for determining the corresponding output value for various combinations of bit values in the word used to access the look up table. The output value relates to the multiplication of those bits by the coefficients. As a first step, the head and the tail of the 36-bit data structure discussed in the previous figure are combined in respective head and tail registers and utilized to access the look up table or equivalent logic to produce an outgoing value Y_0 . In step 2, word#1 is utilized to look up a corresponding value Y_1 in ROM 1600. In step 3, word#2 is utilized to lookup a value Y_2 from ROM 1610. In step 4, word#3 is "twisted," meaning the bit order is reversed, and utilized to look up the value Y_3 in ROM 1610. In step 5, word#4 is twisted and

utilized to look up the value Y4 from 1600. The values Y0, Y1, Y2, Y3 and Y4 are summed to produce the output. The use of lookup tables in this manner reduces the amount of calculation required and thus power consumption.

Although the calculation process has been described here at a functional level, the actual circuitry utilized for implementation is described more in conjunction with the following figures.

Figures 17A and 17B together illustrate hardware preferably utilized to implement the sinc filter number 1 shown in Figure 14. Returning momentarily to the modulator data interface 730 of Figure 7, the three data inputs MDATA(1) MDATA(2) and MDATA(3) are applied to the modulator data interface. These inputs correspond to the channel 1 (CH1), channel 2 (CH2) and channel 3 (CH3) inputs to respective buffers 700. Words stored in buffers 1700 are transferred to respective pages of RAM 1710. The head and tail values are written to respective head and tail registers 1720 and 1730. The combined values from the head and tail registers of a given data plane are combined to form a small look up table address, which in the example shown, is a ROM address which is utilized as shown in Figure 17B. Similarly, the words stored in a particular data plane 1710 are read out and passed to a large look up table (a ROM in the example illustrated) in either regular or twisted form to facilitate the lookup. Twisting of the word is accomplished in a twist multiplexer 1740 which passes data either in regular or bit reversed order to the output depending on the value of the twist control input. Control logic 1750 provides control signals to portions of the chip shown in Figure 7 and to the second stage sinc filters. A sync signal is received which specifies time zero for purposes of establishing sample intervals. Thus, the reading and writing of data will be based on

the same sample intervals as the remainder of the chip. A three channel handshake is utilized to indicate a request has been received (data ready) and to receive back an acknowledgement (when no error occurs). A head select line permits early storage of the head portion of the register bits so that it will be available when needed in processing. A small ROM address and the ROM address from Figure 17A are applied respectively to small ROM 1760 and large ROM 1770 of Figure 17B. The lookup table output values are selectively applied to an adder via switch multiplexer 1775 which selects the input value to be passed to adder 1780 in accordance with incoming control signals. The output of 1780 is fed back to the input via an accumulator 1790. In this manner, the outputs y0, y1, y2, y3 and y4 as discussed in Figure 16 are combined and passed as a 17-bit output to a second stage sinc filter at a 64 KHz rate.

The second stage sinc filters include sinc#2, sinc#3(1), sinc#3(2), sinc#4 and sinc#5. The mathematics for expressing each of these filters is set forth in figures 18A and 18B. Each of those sinc filters is implemented using a number of words and a number of additions.

Figure 18A symbolically illustrates the operations of shifting an addition utilized in carrying out implementation of sinc filters #2-#5 shown in Figure 14. In the drawing, each binary bit x_i is multiplied by a coefficient which is a power of 2. Multiplication by a power of 2 is equivalent to a shift by a number of places equal to the exponent of the power. When a coefficient has a value which cannot be expressed as an even power of 2, it is decomposed into two terms which when summed together result in the appropriate value for that term. As shown in Figure 18A, for sync 2, the third term has a coefficient of 6, which is not an even power of 2. However, as shown in the dashed box in the right hand

part of the equation for sinc#2, a coefficient of 6 can be stated as $4 \cdot X_{-2} + 2 \cdot X_{-2}$. This term is thus equivalent to $6 \cdot X_{-2}$.

Figure 18B shows the expressions which can be used to implement sinc filters sinc#3-sinc#5.

Figure 19A is a block diagram of a single-control, multiple datapath architecture utilized in implementing sinc filters sinc#2 through sinc#5 of Figure 14. The shifting and the additions necessary to implement a particular sinc filter as discussed in conjunction with Figures 18A and 18B are implemented in the circuitries shown in Figure 19. A sequence controller 1900 receives the handshaking from the first stage as previously discussed, a signal indicating whether one or three channels are implemented, clock **rate to be used** and a decimation factor. A plurality of commands are read from the command table such as ROM 1910 and the commands sequentially read out are applied to the command execution unit 1920. The 16 kHz 17-bit signals from the first stage comprising a 16 bit value and a sign bit are applied to respective data planes 1930-i which act as incoming buffers. As the respective words emerge from the buffer, they are stored in respective individual pages of RAM 1940. As individual words are read out of individual data planes 1940, they are applied to shift multiplexer 1950 where they are selectively shifted in accordance with the shift control code applied to the mux and applied to one input of adder 1960. As before, the output of the adder is applied to the input of an accumulator 1970 and that output is applied to a second input of the adder. The output of the adder can either be recirculated over gate 1980 or applied as a 24-bit output to the digital signal processor over mux 1990. By controlling the sequence of the data circulation, in a pipeline arrangement, one can implement the multiple sinc filters needed for a particular decimation ratio. Thus,

the second stage shown in Figure 14 can be implemented using the arrangement shown in Figure 19.

Advantages of the single-control multiple datapath are:

5 A. Gate clocks to each datapath independently allows unused channels to be turned "off" for low power.

 B. Run the complete block at a lower clock rate than for a design where a single datapath is used for multiple channels. This provides a linear reduction in
10 clocks. (i.e. if 3 channels on 1 datapath require 1MHZ, then 3 channels on 3 datapaths can be done in $1\text{MHZ}/3 = 333.3\text{kHz}$.)

 C. Arbitrarily add or remove channels to the design very easily with no modification to the control.

15 D. All channels generally are guaranteed to run the same code, so writing the code is easier (only consider 1 channel, not 3), and the multiple channels don't need to be interleaved in time (i.e. don't need to split code for ch 1, ch 2, ch 3 and so on).

20 E. The code for each channel must still be interleaved with the incoming data to spread out the computations so that the minimum clock frequency can be used.

 Figure 19B shows programming or logic used in item
25 1910 of Figure 19A. The example shown in Figure 19B follows the ordering needed to implement the A-O mode multiplexing discussed hereinafter in conjunction with Figure 21C. If implemented in logic, there is a main routine, each activated by one of eight command lines.
30 The main routine calls subroutines, in this case, also implemented in logic. In the example shown in line 1 of the main routine, there are two subroutine calls, the first to $\text{sinc } 3(1)_A$ and the second to $\text{sinc } 5_0$. Each of those routines is implemented in the subroutine logic or
35 an equivalent RAM. The subroutine $\text{sinc } 3(1)_A$ comprises two lines of microcode implemented in logic and the

subroutine sinc 5₀ comprises six lines of microcode implemented in logic.

Figure 20 is a block diagram showing how a linear phase FIR sinc filter can be improved by decomposition of the calculations into two stages. It is possible to reduce the hardware requirements and the calculation rate needed for implementing a particular sinc filter by splitting the processing across two stages. This principle is illustrated in Figure 20 in which a data value is multiplied by a respective set of coefficients and their values delayed and summed with subsequent products. If the process shown at the top half of Figure 20 where to be separated into two phases, namely first an accumulate phase (A phase) and then an output phase (O phase), as shown in the bottom half of Figure 20 the total number of registers needed can be reduced from 4 to 2 resulting in considerable power savings and in savings of silicon real estate.

Figure 21A illustrates this principle using a factor of eight decimation such as might be utilized in one configuration of the circuitry of Figure 14. The pipeline shown in Figure 21A will be used as an example comparing the calculation requirements at various points in time using the techniques described herein.

Figure 21B shows the calculations required to carry out the factor of eight decimation shown in Figure 21A. One can see that various amounts of calculation occur at alternative sample instances when no multiplexing is employed. That is, calculations are fairly intensive at one instant but non-existent at another instant. Even during those instances in which calculation occurs, the amount of calculation varies from sample instant to sample instant. The clock rate must be high enough to handle the largest number of calculations per sample insert.

Figure 21C shows an improved allocation of calculations resulting from the decomposition of FIR processing into two stages as discussed in conjunction with Figure 20. Using the A-O mode of multiplexing described in conjunction with Figure 20, the amount of calculation is spread out over all instances but the peak amount of calculation required is considerably reduced. Since the peak amount of calculation is reduced, the clock rate can be reduced, saving power.

Figure 21D shows a further improvement in processing allocation resulting from equalization of calculation across all sampling instances. Here, each sample instant has an identical amount of calculation going on. The architecture of the second stage sinc filter as shown in Figures 19A-19C, permits each of these options to be implemented as desired. Because of the flexibility of that architecture, any of the approaches shown in Figure 21B, 21C or 21D can be carried out.

If one were to estimate the calculations required for the different sinc filter approaches shown in figures 21B, 21C and 21D, assuming that an equivalent computation rate was equal to the sample frequency times the number of additions, times three channels, where one addition means one 24-bit addition/subtraction, one would observe the following results.

	R=16	R=32	R=64	R=96	R=128
CIC DIRECT STRUCTURE	9,792	10,656	10,512	11,616	11,592
CIC CASCADE STRUCTURE	10,080	8,034	7,458	5,836	5,673
FIR STRUCTURE	1,832	2,216	2,024	2,024	1,928

One can see that the inventive linear phase FIR filter structure implementation described above results in a greatly reduced computation rate when compared with direct or cascade CIC structures. The reduced calculations will result in significant power savings.

Additional power savings can be achieved through the construction of regulator/switched converter 770 shown in Figure 7. Switch converters are known in the art. One such switch converter is described in an article entitled "HIGH-EFFICIENCY LOW-VOLTAGE DC-DC CONVERSION FOR PORTABLE APPLICATIONS" by Anthony J. Stratakos et al. of the University of California at Berkley and described at pages 105-110 of the IWLPD '94 Workshop Proceedings. Figure 22 shows a switched power converter of a type described in the article. A square wave input is applied in parallel to the gates of a PMOS and NMOS device. The PMOS and NMOS devices are connected in series. An output from the junction of the drain and source of the PMOS and NMOS devices is applied to an inductor L1 and the other end of the inductor is provided to a smoothing capacitor C1 and an output line to provide voltage for the integrated circuit chip.

Figure 23 shows an improved switched power converter in accordance with the invention. In accordance with the invention, the prior art switching convertor is modified by inclusion of a break before make circuit 2300. This ensures that none of the devices is turned on substantially completely before the other device is turned off, thus avoiding switching problems of the prior art and their accompanying power consumption.

The implementation of this break before make circuit 2300 is shown more in detail in Figure 24. The clocking input is applied to a NAND gate I1 and a NOR gate I2. The A input on each gate is inverted. The output of the gates I1 and I2 drive respective chains of inverters, the output of which is fed back to one of the inputs of the

gates by inverters I7 and I8, respectively. Thus, when enabled, the circuit of Figure 24 ensures that one of the two series transistors of the switched converter is opened (turned off) before the other is closed (turned on).

The circuit shown in Figure 23 has yet other benefits of that shown in the prior art. As shown in Figure 23, the square wave generator 2320 which drives the break before make circuit 2300 is controlled by a mode register 2310. The mode register permits the chip voltage to be set by commands sent over the command link 200 and applied to the regulator/SC converter over the TMI bus shown in Figure 7. The value in the mode register controls both the duty cycle of the square wave, which permits the output voltage V_{chip} to be set, as well as the phase of the square wave generated. The ability to adjust and control the phase of the square wave is particularly critical because the switching generated by the switched converter has a sharp rise time and fall time which translate into relatively high frequency components which can be coupled easily as noise into other circuits. By being able to control the phasing of the square wave, the noisy transition instants in the switching converter can be set to occur at a time when sensitive signal processing functions are not going on. For example, during charge transfer using a switched capacitor input circuit to sample the analog output value of a seismic sensor, one would prefer to have as little noise as possible in the neighborhood. The switching transition instance for the switch converter can be set so as to occur when such sensitive charge sampling operations are not occurring. The power on reset circuit shown in Figure 7 of the drawings applies to protocol which is advantageous in ensuring correct startup of the chip.

Figure 25 shows a set of timing diagrams which describe that operation. When the 5 volt VDD is first applied (2500) it rises from 0 volts to its supply value of approximately 5.0 volts. Once the value of the applied VDD rises to a point which exceeds three times the threshold voltage of the devices in question, the power on reset circuit is activated (2510) and the phase locked loop begins its oscillation. When power is first applied, the duty cycle for the switched converter is held to unity, that is, it is always on. Thus, the output voltage of the switched converter rises above its 2.5 volt VDD line and reaches 5.0 volts (2520). After the output of the switched converter is stabilized at 5 volts, the duty cycle hold on the switched converter is released and the switched converter seeks the output value programmed for it by the mode register (2530) and the switched converter begins to seek its programmed value. After a time T_{SC_SETTLE} , the 2.5 VDD output, or equivalent value set in the mode register, is stabilized and the hold applied to all clocks is released and the chip begins to operate.

Figure 26 shows a similar power on reset operation utilized when the power source is controlled by a regulator. However, in this case, the switched converter is not utilized but rather a regulated version of an external power source is used. The external power source functions as the 5 volt VDD line did in the discussion of Figure 25 and time lines having corresponding labels to those shown in Figure 25 behave as described previously. However, since the switched converter is not utilized, those time lines are not shown. In addition, the 2.5 volt VDD line begins rising gradually as plot power is applied until it reaches a stable, in this case 2.5 volt level. At that time, after expiration of time T_{resetz} , the hold on all clocks is released and the chip begins to function. An optional reset mode is used in a third mode

which the time required for reset is reduced to a few clock cycles. This is used for testing on, for example, an industrial IC tester. This is possible because the voltage ramps on such a tester are well defined and a long time for voltages to stabilize isn't needed.

Figure 27 is a flow chart of the process described in conjunction with Figure 25. VDD is applied (2700) and when the applied VDD exceeds $3V_{th}$ (2710) the PLL starts (2720). The SC duty cycle is set to hold at about 100% (2730) and when the SC output nears VDD, the duty cycle hold is released and the switched converter is allowed to have settled to its nominal voltage established in the mode register (2740). Once it is settled, all clocks are released with the next clock reset pulse (2750).

The clock recovery and reset logic 725 shown in Figure 7, contains a phase lock loop which is phase locked to the command line 1 Mbps Manchester encoding rate. In Manchester encoding, an up transition or a down transition in the center of the sample window is interpreted as a logic 1 or a logic 0. The PLL locks on to these transitions, although the output of the PLL is preferably, in this example, 16 times the 1 Mbps rate of the Manchester encoding. This 16 Mbps clock signal is utilized as a master chip clock and all clocks on the chip are derived from this clock.

It has been found particularly advantageous to generate all clocks internal to the chip so that they coincide with the rising edge of the chip clock. All noise critical clocks provided external to the chip, such as ones provided to the ADC interface 110 shown in Figure 1 are created on the falling edge of the chip clock.

All clocks on the chip shown in Figure 7 are programmable. That is, the division ratio used to obtain a particular clock rate from the chip clock can be programmed. Not only that, they can be programmed during the operation of the chip. The registers setting the

dividers for the various clocks can be programmed over the TMI bus using information received over the command line. Thus, the central processing and recording unit 160 can set individual clock rates on the chips. The arrangement execution of a change in the programming for a particular clock can occur only when a chip sync pulse occurs. This occurs typically at a 32 kHz rate.

Figure 28 shows a plurality of time lines showing clock alignment associated with on-chip generation of clocks in accordance with the invention. These time lines illustrate the principles just discussed. In Figure 28, CLK 16 is the clock to which all other clocks are locked. A plurality of additional clocks, CLK 8, CLK 4, CLK 2, CLK 1, CLK 512 and CLK 256 are each derived from CLK 16 by a programmable division, in this case by an even power of 2. These clocks operate at 8 MhZ, 4 MhZ, 1 MhZ, 512 KhZ and 256 KhZ, respectively. In addition, an S clock signal is derived and a clock sync signal CLKSYNC occurs every 8 milaseconds which resets the clock dividers and ensures that all clocks operate in lock. A plurality of ADC clocks are shown. These clocks may be, for example, clocks associated with the ADC interface 110 shown in Figure 1. They are utilized for controlling whatever operations might be desirable within that circuit. In this case, a plurality of different clocks are shown. However, what is important is that each of these clocks utilized with off chip devices are generated on the falling edge of CLK 16. Thus, the activities which occur on the chip shown in Figure 7 will occur at different instances from the activities occurring on external devices. This provides considerable advantage when dealing with noise and other design issues. The synchronization of clocks on a chip, in this case for example on the RSU chip is particularly advantageous because it eases the interfacing of on chip components because of the known time relationships.

Figure 29 is a block diagram showing how clock reprogramability is implemented in accordance with the invention. This process is described in conjunction with Figure 28 in which a 16 megabit per second chip clock is provided to a programmable divider 2900 which divides the clock down to a local chip clock frequency 2910. A register 2920 is connected to the TMI bus 705 so that the value in the register 2920 can be programmed from the TMI bus. However, the revised value in the register 2920 cannot be applied to the programmable divider 2900 until the occurrence of a sync pulse 2930.

By switching the programming of a clock during the sync pulse, the clock can be reprogrammed during operation without cause causing glitches in the data. Further, data interfacing among devices on the chip is easier when all clocks on the chip are synchronized.

A problem exists when implementing mathematics in the DSP. The problem is that many adder circuits do not correctly determine a carry bit. In accordance with the invention, a carry detection circuit has been developed which can detect correctly the carry bit of $X * Y + \text{Accumulator} + \text{round}$. $X * Y + \text{Accumulator}$ has been called MAC traditionally. Previous work has been addressed to $X * Y + \text{Accumulator}$. However, with rounding, the circuit is not obviously correct and is, in fact, many times incorrect because the intermediate values are scrambled. The carry detection circuit described here overcomes this problem.

The following 5 steps are undertaken in order to determine the carry bit correctly.

1. Determine if product is negative.
2. Determine if accumulator is negative.
3. Determine if the round-bit propagates all the way to the most significant bit, MSB.
4. Determine if result ($X * Y + \text{Accumulator} + \text{round}$) is negative.

5. Determine a correct carry bit (based on previous 4 results).

The actual circuit implementation of the previous steps are described as follows.

5 1. negative product bit: (proof 1)
(multinA[MSB] ^ multinB[MSB]) && |multinB && |multinA
multinA : an N-bit 2's complement number
multinB : an N-bit 2's complement number
MSB : "Most Significant Bit" i.e. bit N-1
10 Note: one counts bit 0, bit 1,... bit N-1.
Thus, the number of bits is equal to N,
but the most significant one is bit N-1.
^ : logical XOR operation
&& : logical AND operation
15 | : bitwise logical OR operation
e.g. |multinB means multinB[N-1] OR multinB[N-
2] OR...
... OR multinB[0]
2. negative accumulator bit:
20 acc[MSB]
acc : 2's complement number of Accumulator
Note that acc has > 2N bits to store results
of
previous multiplications.
25 e.g. 1010 * 0101 = 11100010
thus, 4-bit number * 4-bit number becomes 8-bit
number.
It is a property of 2's complement number that the
MSB is
30 the sign bit.

3. round-bit propagates to MSB bit: (proof 3)
 Let i be the bit that round is added to accumulator
 output

rndprop (round-propagate) bit :

5 round && (result[MSB:I] all zero)

result : X * Y + Accumulator + round

round : user can choose to round or not. 1 means
 yes,

0 means no

10 i : usually is bit N-1

e.g. 1010 * 0101 + 11000011 + 00001000

acc round

N = 4, thus, 4 bit operands, acc has 8 bits, and round is
 added at bit 3 (i.e. N-1).

15 4. negative result bit:

result[MSB]

result : X * Y + Accumulator + round

5. (x is don't care) (proof 5)

20 casex ({sign_Product, sign_Acc, sign_Result,
 rndprop}))

25 4'b0000: cout <= 0;
 4'b0001: cout <= 1;
 4'b001x: cout <= 0;
 4'b010x: cout <= 1;
 4'b0110: cout <= 0;
 4'b0111: cout <= 1;
 4'b100x: cout <= 1;
 4'b1010: cout <= 0;
 4'b1011: cout <= 1;
 30 4'b110x: cout <= 1;
 4'b111x: cout <= 1;
 endcase

sign_Product: negative product bit from 1.

sign_Acc : negative accumulator bit from 2.

sign_Result : negative result bit from 4.
 Rndproop : round-bit propagate to MSB bit from 3.

5 Note: There should be 2 carry bits (proof 5).
 However, as implemented they are logically ORed
 together, just to make it fit the traditional
 circuit.

The following are 2 examples which illustrates 3 and 5.
 Finally, the proof for 1, 3, and 5 are provided.

10 The area of this carry detection circuit, as in proof 5,
 is:

1 nr2 (2 p 2 n)
 3 inv (1 p 1 n)
 1 ao21 (4 p 4 n)
 1 oai2211 (5 p 5 n)

15 Total: 6 logic gates 14 p 14 n

nr2 : logical 2 input NOR gate, i.e. $\sim (J \parallel K)$
 inv : logical inverter i.e. $\sim J$
 ao21 : logical 2 input AND-OR, i.e. $(J \&\& K) \parallel$
 L
 20 oai2211 : logical OR-AND-INV i.e. $\sim ((J \parallel K) \&\&$
 (L \parallel M))

The area of 1, 3, can be shared with different
 overflow, and zero detection circuit, which is usually in
 place with the carry out circuit.

25 EXAMPLES

Here is a brief examples of how 3, and 5 works.

example for proof 3

The following are all binary numbers:

(0 is zero, 1 is one, X is don't care)

```

5      result without rounding  XXXXXXXXXXXXXXXX
      plus rounding            + 0000000010000000
                                -----
      result                   000000000XXXXXXX
                                ^
                                |
10      bit k

```

One can deduce that the carryout from the leftmost bit is 1.

Explanation: if one adds 1 at bit k and gets 0 at the output, one knows that there is a carryout to the next bit (k+1) location. Again, if one adds that carry to bit k+1 and get a 0 at the output, one knows that there is a carryout to the next bit (k+2) location. Similar, one can continue on and on, thus deduct that there is a carryout from the leftmost bit.

Example for proof 5

All numbers are 2's complement binary numbers

Suppose one adds two numbers and rounds.

```

25      1111111111111111
      + 1111111111111111
      -----
      1 111111111111110
            ^
            |
            carryout

```

```

30      + 0000000010000000
      -----
10  10 0000000001111110
    ^ ^
    | |
35      2 carryouts

```

Another example:

5 0111111111111111
 + 1111111111111111

 1 0111111111111110
 ^
 |
 carryout

10 + 0000000010000000

 1 1000000001111110
 ^
 |
 carryout

15 The circuit in previous work does not address the
previous situations correctly.

20 Although the present invention has been described
and illustrated in detail, it is clearly understood that
the same is by way of illustration and example only and
is not to be taken by way of limitation, the spirit and
scope of the present invention being limited only by the
terms of the appended claims and their equivalents.

1-8 sets of coefficients of PolyPhase1 (17 bits)

coeff. set#1				
h(1)=-1	h(2)=27	h(3)=-67	h(4)=139	h(5)=-252
h(6)=413	h(7)=-627	h(8)=893	h(9)=-1209	h(10)=1566
h(11)=-1961	h(12)=2407	h(13)=-2992	h(14)=4262	h(15)=65535
h(16)=110	h(17)=-1039	h(18)=1230	h(19)=-1196	h(20)=1058
h(21)=-874	h(22)=678	h(23)=-493	h(24)=333	h(25)=-208
h(26)=116	h(27)=-56	h(28)=23		
coeff. set#2				
h(1)=4	h(2)=15	h(3)=-47	h(4)=109	h(5)=-214
h(6)=374	h(7)=-600	h(8)=905	h(9)=-1296	h(10)=1790
h(11)=-2420	h(12)=3230	h(13)=-4705	h(14)=8606	h(15)=65535
h(16)=-3834	h(17)=1038	h(18)=-100	h(19)=-296	h(20)=447
h(21)=-466	h(22)=116	h(23)=-332	h(24)=242	h(25)=-160
h(26)=94	h(27)=-48	h(28)=21		
coeff. set#3				
h(1)=4	h(2)=16	h(3)=-51	h(4)=121	h(5)=-242
h(6)=431	h(7)=-707	h(8)=1088	h(9)=-1598	h(10)=2271
h(11)=-3178	h(12)=4502	h(13)=-6866	h(14)=13956	h(15)=65535
h(16)=-7117	h(17)=2771	h(18)=-1182	h(19)=414	h(20)=-22
h(21)=-162	h(22)=225	h(23)=-219	h(24)=179	h(25)=-128
h(26)=80	h(27)=-43	h(28)=20		
coeff. set#4				
h(1)=4	h(2)=16	h(3)=-55	h(4)=133	h(5)=-271
h(6)=490	h(7)=-815	h(8)=1276	h(9)=-1909	h(10)=2768
h(11)=-3965	h(12)=5785	h(13)=-9185	h(14)=20170	h(15)=65535
h(16)=-10058	h(17)=4402	h(18)=-2218	h(19)=1100	h(20)=-478
h(21)=134	h(22)=39	h(23)=-108	h(24)=117	h(25)=-97
h(26)=67	h(27)=-38	h(28)=20		
coeff. set#5				
h(1)=6	h(2)=14	h(3)=-53	h(4)=134	h(5)=-282

1-8 sets of coefficients of PolyPhase1 (17 bits)

h(6)=523	h(7)=-389	h(8)=1420	h(9)=-2165	h(10)=3204
h(11)=-4694	h(12)=7030	h(13)=-11567	h(14)=27336	h(15)=65535
h(16)=-12778	h(17)=6009	h(18)=-3273	h(19)=1815	h(20)=-962
h(21)=454	h(22)=-165	h(23)=15	h(24)=48	h(25)=-61
h(26)=51	h(27)=-33	h(28)=19		
coeff. set#6				
h(1)=8	h(2)=9	h(3)=-46	h(4)=127	h(5)=-279
h(6)=535	h(7)=-934	h(8)=1525	h(9)=-2374	h(10)=3587
h(11)=-5372	h(12)=8248	h(13)=-14030	h(14)=35741	h(15)=65535
h(16)=-15302	h(17)=7589	h(18)=-4342	h(19)=2556	h(20)=-1471
h(21)=796	h(22)=-385	h(23)=150	h(24)=-29	h(25)=-21
h(26)=33	h(27)=-26	h(28)=18		
coeff. set#7				
h(1)=11	h(2)=4	h(3)=-37	h(4)=116	h(5)=-270
h(6)=536	h(7)=-963	h(8)=1610	h(9)=-2561	h(10)=3948
h(11)=-6033	h(12)=9478	h(13)=-16632	h(14)=45840	h(15)=65535
h(16)=-17631	h(17)=9120	h(18)=-5402	h(19)=3301	h(20)=-1990
h(21)=1148	h(22)=-614	h(23)=291	h(24)=-110	h(25)=21
h(26)=14	h(27)=-19	h(28)=17		
coeff. set#8				
h(1)=14	h(2)=-3	h(3)=-25	h(4)=99	h(5)=-252
h(6)=526	h(7)=-976	h(8)=1675	h(9)=-2723	h(10)=4283
h(11)=-6676	h(12)=10721	h(13)=-19390	h(14)=58232	h(15)=65535
h(16)=-19790	h(17)=10603	h(18)=-6452	h(19)=4050	h(20)=-2517
h(21)=1507	h(22)=-850	h(23)=437	h(24)=-194	h(25)=64
h(26)=-6	h(27)=-12	h(28)=16		

APPENDIX A (CONTINUED)

1-8 sets of coefficients of PolyPhase2 (17 bits)

coefficients set#1				
h(1)=7	h(2)=37	h(3)=73	h(4)=-136	h(5)=221
h(6)=-329	h(7)=453	h(8)=-581	h(9)=694	h(10)=-763
h(11)=741	h(12)=-519	h(13)=-377	h(14)=65535	h(15)=3463
h(16)=-2306	h(17)=1798	h(18)=-1431	h(19)=1119	h(20)=-847
h(21)=613	h(22)=-419	h(23)=268	h(24)=-157	h(25)=81
h(26)=-39	h(27)=7			
coefficients set#2				
h(1)=7	h(2)=-37	h(3)=74	h(4)=-138	h(5)=226
h(6)=-337	h(7)=467	h(8)=-603	h(9)=728	h(10)=-814
h(11)=819	h(12)=-644	h(13)=-125	h(14)=65535	h(15)=3203
h(16)=-2193	h(17)=1734	h(18)=-1393	h(19)=1097	h(20)=-834
h(21)=605	h(22)=-416	h(23)=266	h(24)=-157	h(25)=81
h(26)=-39	h(27)=7			
coefficients set#3				
h(1)=7	h(2)=-38	h(3)=75	h(4)=-141	h(5)=230
h(6)=-346	h(7)=481	h(8)=-625	h(9)=761	h(10)=-865
h(11)=896	h(12)=-769	h(13)=128	h(14)=65535	h(15)=2944
h(16)=-2080	h(17)=1670	h(18)=-1354	h(19)=1073	h(20)=-820
h(21)=598	h(22)=-412	h(23)=265	h(24)=-156	h(25)=81
h(26)=-39	h(27)=7			
coefficients set#4				
h(1)=8	h(2)=-38	h(3)=76	h(4)=-143	h(5)=235
h(6)=-354	h(7)=494	h(8)=-647	h(9)=795	h(10)=-915
h(11)=972	h(12)=-894	h(13)=382	h(14)=65535	h(15)=2686
h(16)=-1966	h(17)=1606	h(18)=-1315	h(19)=1050	h(20)=-806
h(21)=590	h(22)=-408	h(23)=263	h(24)=-156	h(25)=81
h(26)=-39	h(27)=7			
coefficients set#5				
h(1)=8	h(2)=-38	h(3)=77	h(4)=-145	h(5)=239

1-8 sets of coefficients of PolyPhase2 (17 bits)

h(6)=-362	h(7)=308	h(8)=-668	h(9)=827	h(10)=-965
h(11)=1048	h(12)=-1018	h(13)=637	h(14)=65535	h(15)=2429
h(16)=-1852	h(17)=1541	h(18)=-1276	h(19)=1026	h(20)=-792
h(21)=582	h(22)=-404	h(23)=261	h(24)=-155	h(25)=81
h(26)=-39	h(27)=8			
coefficients set#6				
h(1)=8	h(2)=-39	h(3)=78	h(4)=-147	h(5)=244
h(6)=-369	h(7)=521	h(8)=-689	h(9)=860	h(10)=-1014
h(11)=1124	h(12)=-1142	h(13)=894	h(14)=65535	h(15)=2174
h(16)=-1738	h(17)=1476	h(18)=-1236	h(19)=1001	h(20)=-777
h(21)=574	h(22)=-399	h(23)=259	h(24)=-154	h(25)=81
h(26)=-39	h(27)=8			
coefficients set#7				
h(1)=8	h(2)=-39	h(3)=79	h(4)=-149	h(5)=248
h(6)=-377	h(7)=533	h(8)=-709	h(9)=891	h(10)=-1062
h(11)=1198	h(12)=-1265	h(13)=1151	h(14)=65535	h(15)=1919
h(16)=-1622	h(17)=1410	h(18)=-1195	h(19)=976	h(20)=-762
h(21)=565	h(22)=-395	h(23)=257	h(24)=-153	h(25)=80
h(26)=-39	h(27)=8			
coefficients set#8				
h(1)=8	h(2)=-39	h(3)=80	h(4)=-151	h(5)=251
h(6)=-384	h(7)=545	h(8)=-728	h(9)=921	h(10)=-1109
h(11)=1271	h(12)=-1387	h(13)=1409	h(14)=65535	h(15)=1665
h(16)=-1506	h(17)=1342	h(18)=-1153	h(19)=950	h(20)=-746
h(21)=556	h(22)=-390	h(23)=254	h(24)=-152	h(25)=80
h(26)=-39	h(27)=8			

APPENDIX B (CONTINUED)

Half of the FIR filter coefficients of Sinc #1 (not normalized)

$h_0=1$	$h_1=5$	$h_2=15$	$h_3=35$	$h_4=70$	$h_5=126$	$h_6=210$	$h_7=330$	$h_8=490$
$h_9=690$	$h_{10}=926$	$h_{11}=1190$	$h_{12}=1470$	$h_{13}=1750$	$h_{14}=2010$	$h_{15}=2226$	$h_{16}=2380$	$h_{17}=2460$

N/2 coefficients of linear phase FIR1 (24 bits), N=38

h(1)=-3363	h(2)=-12069	h(3)=-27056	h(4)=-43884	h(5)=-36017
h(6)=17858	h(7)=128486	h(8)=266726	h(9)=321261	h(10)=179350
h(11)=-228950	h(12)=-821735	h(13)=-1280574	h(14)=-1190828	h(15)=-180214
h(16)=1820850	h(17)=4419986	h(18)=6887230	h(19)=8388607	

APPENDIX D

N/2 coefficients of linear phase FIR2 (24 taps), N=126

h(1)=-71	h(2)=-371	h(3)=-870	h(4)=-986	h(5)=34
h(6)=1786	h(7)=2291	h(8)=291	h(9)=-2036	h(10)=-943
h(11)=2985	h(12)=3784	h(13)=-1458	h(14)=-5808	h(15)=-1007
h(16)=7756	h(17)=5935	h(18)=-7135	h(19)=-11691	h(20)=3531
h(21)=17500	h(22)=4388	h(23)=-20661	h(24)=-15960	h(25)=18930
h(26)=29808	h(27)=-9795	h(28)=-42573	h(29)=-7745	h(30)=49994
h(31)=33021	h(32)=-47092	h(33)=-62651	h(34)=29702	h(35)=90744
h(36)=4436	h(37)=-109189	h(38)=-54172	h(39)=109009	h(40)=114154
h(41)=-81993	h(42)=-174452	h(43)=22850	h(44)=221211	h(45)=68863
h(46)=-238025	h(47)=-187141	h(48)=208018	h(49)=318763	h(50)=-116005
h(51)=443272	h(52)=-49958	h(53)=533334	h(54)=298975	h(55)=-553873
h(56)=-642475	h(57)=454990	h(58)=1113788	h(59)=-137179	h(60)=-1854336
h(61)=-766230	h(62)=3875315	h(63)=8388607		

APPENDIX E

126 coefficients of minimal phase FIR2 filter (24 bits)

h(1)=3706	h(2)=40279	h(3)=221174	h(4)=804845	h(5)=2146750
h(6)=4386648	h(7)=6953394	h(8)=8388607	h(9)=7090455	h(10)=2835288
h(11)=-2253524	h(12)=-4797671	h(13)=-3039496	h(14)=1134795	h(15)=3610933
h(16)=2087476	h(17)=-1456651	h(18)=-2946553	h(19)=-879504	h(20)=1992768
h(21)=2134637	h(22)=-387002	h(23)=-2162107	h(24)=-976715	h(25)=1372312
h(26)=1679514	h(27)=-297702	h(28)=-1691061	h(29)=-639397	h(30)=1204628
h(31)=1205395	h(32)=-489236	h(33)=-1344382	h(34)=-210444	h(35)=1127050
h(36)=726304	h(37)=-690038	h(38)=-980767	h(39)=183586	h(40)=976368
h(41)=266088	h(42)=-771300	h(43)=-576454	h(44)=452150	h(45)=714614
h(46)=-107673	h(47)=-690048	h(48)=-188586	h(49)=543320	h(50)=390793
h(51)=-328349	h(52)=-480675	h(53)=101449	h(54)=467877	h(55)=94397
h(56)=-376347	h(57)=-223622	h(58)=243508	h(59)=294668	h(60)=-99375
h(61)=-292935	h(62)=-22457	h(63)=246890	h(64)=113456	h(65)=-167811
h(66)=-157090	h(67)=86258	h(68)=164188	h(69)=-15171	h(70)=-145799
h(71)=-41105	h(72)=106515	h(73)=72363	h(74)=-61723	h(75)=-80669
h(76)=22236	h(77)=72792	h(78)=6664	h(79)=-56130	h(80)=-23869
h(81)=36838	h(82)=30867	h(83)=-19148	h(84)=-30380	h(85)=5374
h(86)=25381	h(87)=3750	h(88)=-18458	h(89)=-8569	h(90)=11516
h(91)=10031	h(92)=-5702	h(93)=-9276	h(94)=1510	h(95)=7366
h(96)=1051	h(97)=-5118	h(98)=-2258	h(99)=3067	h(100)=2511
h(101)=-1480	h(102)=-2203	h(103)=423	h(104)=1657	h(105)=168
h(106)=-1089	h(107)=-411	h(108)=619	h(109)=440	h(110)=-288
h(111)=-359	h(112)=89	h(113)=249	h(114)=9	h(115)=-148
h(116)=-42	h(117)=76	h(118)=42	h(119)=-31	h(120)=-29
h(121)=10	h(122)=16	h(123)=-1	h(124)=-7	h(125)=-1
h(126)=3				

APPENDIX F

APPENDIX G

PROOFS

Here is the Proof for steps 1, 3 and 5.

Proof 1

negative product bit:

product of 2 numbers is negative iff
operand 1 is positive and operand 2 is negative or vice
versa.

(Notice that if one number is zero, the result is zero,
i.e. non-negative.)

Thus,

put in logic:

$(\text{op1}[\text{MSB}] \wedge \text{op2}[\text{MSB}]) \&\& |\text{op1} \&\& |\text{op2}$

The 1st term is true iff the sign bit of the 2 operands
are different.

The 2nd term is true iff op1 is $\neq 0$.

The 3rd term is true iff op2 is $\neq 0$.

Therefore, for the whole expression to be true, op1 and
op2 are both non-zero numbers of different polarity,
Or the product of op1 and op2 is negative.

Circuit:

9	nr31	6 transistors	(3 p 3 n)
2	or31	8 transistors	(4 p 4 n)
2	or41	10 transistors	(5 p 5 n)
2	nd4	8 transistors	(4 p 4 n)
2	nr8	22 transistors	(11 p 11 n)
1	xnor2	10 transistors	(5 p 5 n)
total:		160 transistors	
		(119 synopsys area)	

APPENDIX G CONTINUED

Proof 3

Let proposition $P(i, \text{const})$ means

For any binary number bnum and any integer const , add 1 to $\text{bnum}[\text{const}]$:

if the $\text{sum}[\text{const}] == \text{sum}[\text{const}+1] == \text{sum}[\text{const}+2] == \dots == \text{sum}[\text{const}+i] == 0$, then carryout from $\text{res}[\text{const}+i] == 1$

- a. Examine $P(0, \text{const})$:
add 1 to $\text{bnum}[\text{const}]$,
(Proof by negation)

assume carryout from $\text{sum}[\text{const}+0] \neq 1$
 \Rightarrow carryout from $\text{sum}[\text{const}+0] == 0$ (binary number)
 $\Rightarrow 1 \ \&\& \ \text{bnum}[\text{const}] == 0$ (carryout equation)
 $\Rightarrow \text{bnum}[\text{const}] == 0$ (and property)
 $\Rightarrow 1 \wedge \text{bnum}[\text{const}] == 1$ ($1 \wedge 0 = 1$)
 $\Rightarrow \text{sum}[\text{const}] == 1$ ($1 \wedge 0 = \text{sum}$)

Thus,

For any binary number bnum and any integer const ,
add 1 to $\text{bnum}[\text{const}]$:

if $\text{sum}[\text{const}] \neq 1$, then carryout from $\text{sum}[\text{const}] == 1$;

Or,

For any binary number bnum and any integer const ,
add 1 to $\text{bnum}[\text{const}]$:

if $\text{sum}[\text{const}] == 0$, then carryout from $\text{sum}[\text{const}] == 1$.

- b. Assuming $P(n, \text{const})$ is true for all integer $n < \text{any integer } k$

- c. Examine $P(k+1, \text{const})$:
add 1 to $\text{bnum}[\text{const}]$,
1 assume $\text{sum}[\text{const}] == \text{sum}[\text{const}+1] == \dots == \text{sum}[\text{const}+k+1] = 0$

APPENDIX G CONTINUED

```
2  => cout from sum[const], sum[const], ...
sum[const+k] == 1
      (By P(0, const), P(1, const), ... P(k, const))
3  => cout from sum[const+k] == cin to sum[const+k+1]
== 1 (add)
4  => cin to sum[const+k+1] ^ bnum[const+k+1] == 0 (1)
5  => 1 ^ bnum[const+k+1] == 0 (3)
6  => bnum [const+k+1] == 1 (xor)
7  => 1 && bnum [const+k+1] == 1 (and)
8  => cout [const+k+1] == 1
```

Thus,

For any binary number bnum and any integer const,
add 1 to bnum [const]:

if sum [const] == sum [const+1] == ... ==
sum[const+k+1] == 0,

then, cout from sum [const+k+1] == 1.

From a., b., c. and principles of mathematical induction,

For any binary number bnum and any integer const,
add 1 to bnum [const]:

if sum [const] == sum [const+1] == ... == sum
[const+n] == 0,

then, cout from sum [const+n] == 1. (for all
integer n >= 0)

Proof (5) of carry logic:

Case without rounding:

For case without rounding, the carryout bit from MSB is
easy to determined.

```
(Sign_Product && Sign_Acc) || ( Cin && (Sign_Product ||
Sign_Acc))
```

APPENDIX G CONTINUED

However, we do not have Cin to MSB. Thus, we have to find Cin to MSB from the Sign_Res.

$$\begin{aligned} \text{Sign_Res} &= \text{Sign_Product} \wedge \text{Sign_Acc} \wedge \text{Cin} \\ \rightarrow \text{Cin} &= \text{Sign_Product} \wedge \text{Sign_Acc} \wedge \text{Sign_Res} \end{aligned}$$

Put back to previous equation:

```
casex ({sign_Product, sign_Acc, sign_Result})
  3'b000: cout <= 0;
  3'b001: cout <= 0;
  3'b010: cout <= 1;
  3'b011: cout <= 0;
  3'b100: cout <= 1;
  3'b101: cout <= 0;
  3'b110: cout <= 1;
  3'b111: cout <= 1;
```

Case with rounding:

For case with rounding, the carryout bit from MSB is determined this way.

$$\begin{aligned} \text{Co0} &= \text{SUM2}(\text{sign_Prod}, \text{Sign_Acc}; \text{Cin}, \text{Rnd_prop}) \parallel \\ &\quad \text{SUM3}(\text{sign_Prod}, \text{Sign_Acc}, \text{Cin}, \text{Rnd_prop}) \\ &\quad (\text{proof 3}) \end{aligned}$$
$$\text{Co1} = \text{SUM4}(\text{sign_Prod}, \text{Sign_Acc}, \text{Cin}, \text{Rnd_prop})$$

Where Cin is the carry in to MSB without rounding.

As before, Cin can be determined from the Result.

$$\begin{aligned} \text{Sign_res} &= \text{sign_Prod} \wedge \text{sign_Acc} \wedge \text{Cin} \wedge \text{Rnd_prop} \\ \rightarrow \text{Cin} &= \text{sign_Prod} \wedge \text{sign_Acc} \wedge \text{sign_Res} \wedge \text{Rnd_prop} \end{aligned}$$

APPENDIX G CONTINUED

Thus,

```
casex ({sign_Prod, sign_Acc, sign_Res, rnd_prop})
```

```
4'b0000: Co0 <= 0;
4'b0001: Co0 <= 1;
4'b0010: Co0 <= 0;
4'b0011: Co0 <= 0;
4'b0100: Co0 <= 1;
4'b0101: Co0 <= 1;
4'b0110: Co0 <= 0;
4'b0111: Co0 <= 1;
4'b1000: Co0 <= 1;
4'b1001: Co0 <= 1;
4'b1010: Co0 <= 0;
4'b1011: Co0 <= 1;
4'b1100: Co0 <= 1;
4'b1101: Co0 <= 0;
4'b1110: Co0 <= 1;
4'b1111: Co0 <= 1;
```

```
casex ({sign_Prod, sign_Acc, sign_Res, rnd_prop})
```

```
4'b1101: Co1 <= 1;
default: Co1 <= 0;
```

Traditionally, there is one carry bit, thus, I logical OR the previous Co0 and Co1 together, which becomes:

```
casex ({sign_Product, sign_Acc, sign_Result, rndprop})
```

```
4'b0000: cout <= 0;
4'b0001: cout <= 1;
4'b001x: cout <= 0;
4'b010x: cout <= 1;
4'b0110: cout <= 0;
4'b0111: cout <= 1;
4'b100x: cout <= 1;
4'b1010: cout <= 0;
4'b1011: cout <= 1;
4'b110x: cout <= 1;
4'b111x: cout <= 1;
```

```
endcase
```

Synopsys Area: 24

```
1 nr2          (2 p 2 n)
```

```
3 inv          (1 p 1 n)
```

```
1 ao21        (4 p 4 n)
```

```
1 oai2211     (5 p 5 n)
```

Total: 6 logic gates 14 p 14 n

CLAIMS

1. A power on reset circuit, comprising:
 - a. a first circuit for applying a first voltage to said power on reset circuit;
 - b. a circuit for starting a phase locked loop when
5 voltage applied by said first circuit exceeds a threshold and for inhibiting operation of at least a plurality of clocks until released, and
 - c. releasing all inhibited clocks once voltage stability is achieved.
2. The power on reset circuit of claim 1 further comprising a switched converter in which the duty cycle of said switched converter is unity until the output of said switched converter reaches substantially said first
5 voltage.
3. The power on reset circuit of claim 2 in which the duty cycle of said switched converter is programmable.
4. The power on reset circuit of claim 3 in which the duty cycle of said switched converter is reduced from unity after the output of said switched converter reaches substantially said first voltage.
5. The power on reset circuit of claim 3 in which said switched converter settles to a set output voltage before said inhibited clocks are released.
6. The power on reset circuit of claim 1 further comprising a regulator and in which the inhibited clocks are released only after said regulator substantially reaches its stabilized output voltage.

7. The power on reset circuit of claim 1 contained within an integrated circuit.

8. A method of applying power to an integrated circuit, comprising the steps of:

a. applying a first voltage to said integrated circuit;

5 b. when voltage applied to said integrated circuit exceeds a first threshold, setting the duty cycle of a switched converter to substantially unity and placing a hold on the operation of at least one clock on said integrated circuit;

10 c. allowing a phase locked loop to start; and

d. when the output of the switched converter nears said first voltage, reducing the duty cycle of said switched converter; and

15 e. after the output of the switched converter reaches stability, releasing said hold.

9. The method of claim 8 in which the hold on more than one clock is released in stages.

10. The method of claim 8 in which said switched converter is programmable over a bus.

11. The method of claim 10 in which said switched converter is programmable over a communications link exterior to said integrated circuit.

12. A method of applying power to an integrated circuit, comprising the steps of:

a. applying a first voltage to said integrated circuit;

5 b. when voltage applied to said integrated circuit exceeds a first threshold placing a hold on the operation

of at least one clock on said integrated circuit and allowing a phase locked loop to start; and

10 c. when the output of a regulator reaches stability, releasing said hold.

13. The method of claim 11 in which the hold on more than one clock is released in stages.

14. A program product, comprising:

a. a memory medium; and

5 b. control instructions stored on said memory medium, said control instructions causing application of a first voltage to an integrated circuit, when voltage applied to said integrated circuit exceeds a first threshold, setting a duty cycle of a switched converter to substantially unity and placing a hold on the operation of at least one clock on said integrated
10 circuit, allowing a phase locked loop to start; and when the output of the switched converter nears said first voltage, reducing the duty cycle of said switched converter; and after the output of the switched converter reaches stability, releasing said hold.

15. The program product of claim 14 in which said hold is released in stages.

16. A program product, comprising;

a. a memory medium; and

5 b. control instructions stored on said memory medium, said control instructions causing application of a first voltage to said integrated circuit, when voltage applied to said integrated circuit exceeds a first threshold placing a hold on the operation of at least one clock on said integrated circuit and allowing a phase locked loop to start; and when the output of a regulator
10 reaches stability, releasing said hold.

17. The program product of claim 16 in which said hold is released in stages.

POWER ON RESET TECHNIQUES FOR AN
INTEGRATED CIRCUIT CHIP

Abstract of the Disclosure

A power on reset circuit, preferably for an integrated circuit, detects application of voltage, starts a phase locked loop one application of voltage is detected but inhibits all clock used for digital logic operations until voltage stability is achieved. If a switched converter is used, the duty cycle of the switched converter is held at unity for a period of time before it is set to that needed to achieve the desired chip operating voltage. Clocks controlling other circuits can be released in stages after the duty cycle of the switched converter is set to its operating voltage level.

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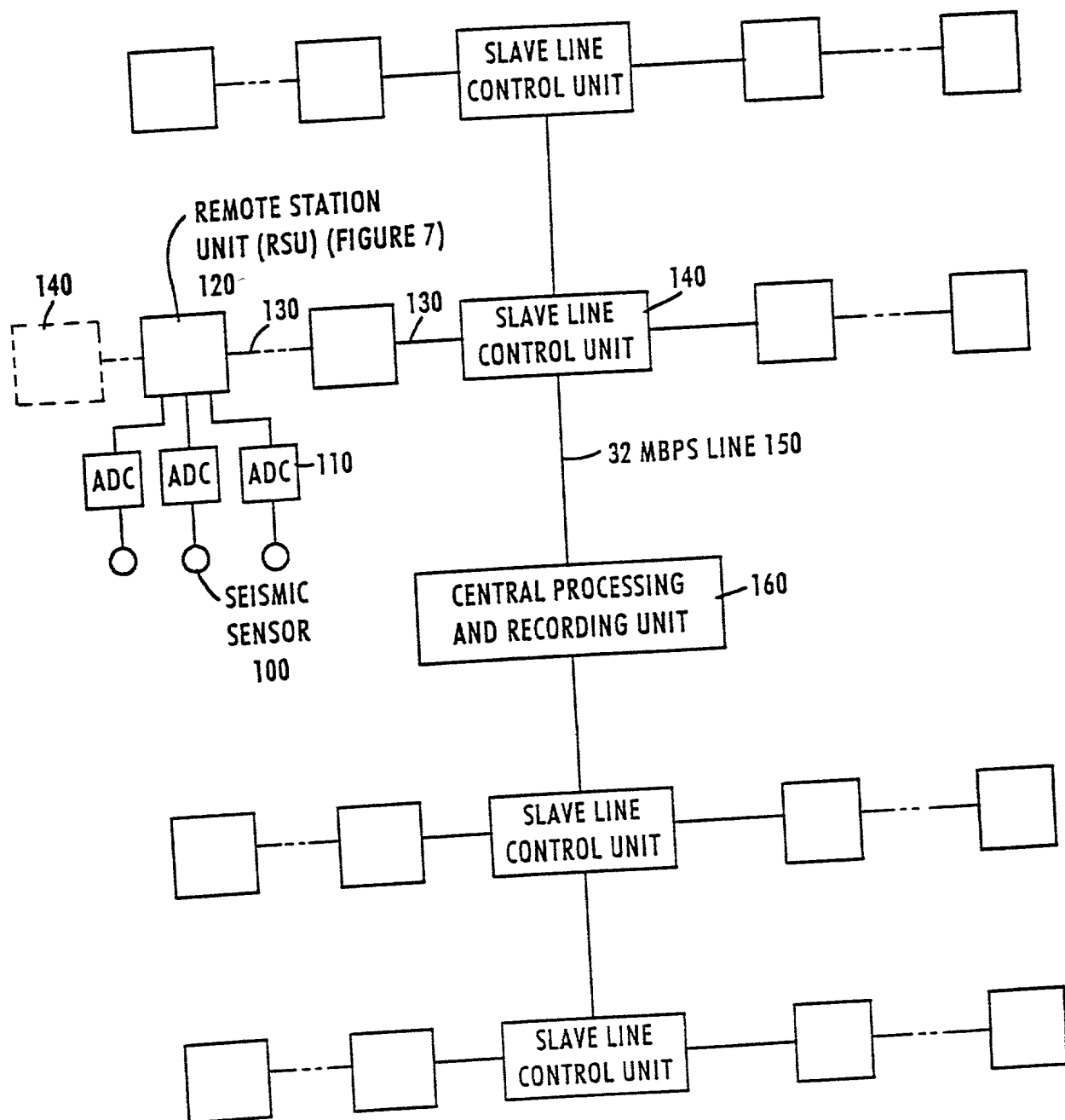


Figure 1

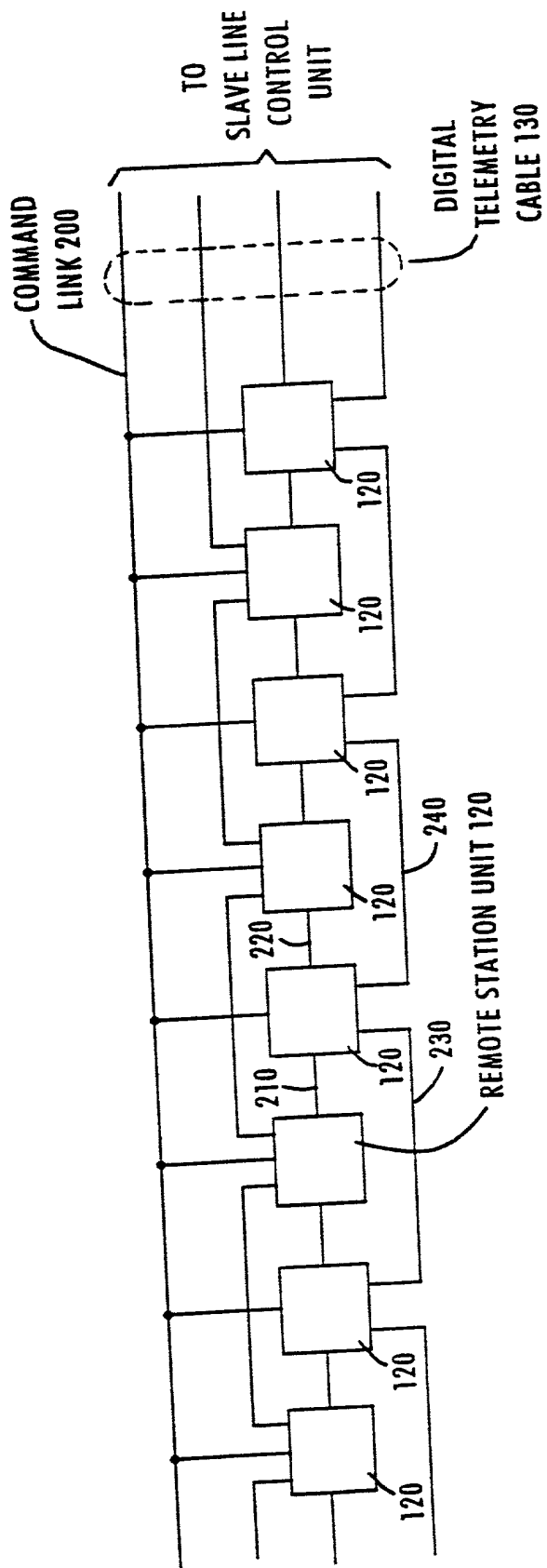


Figure 2

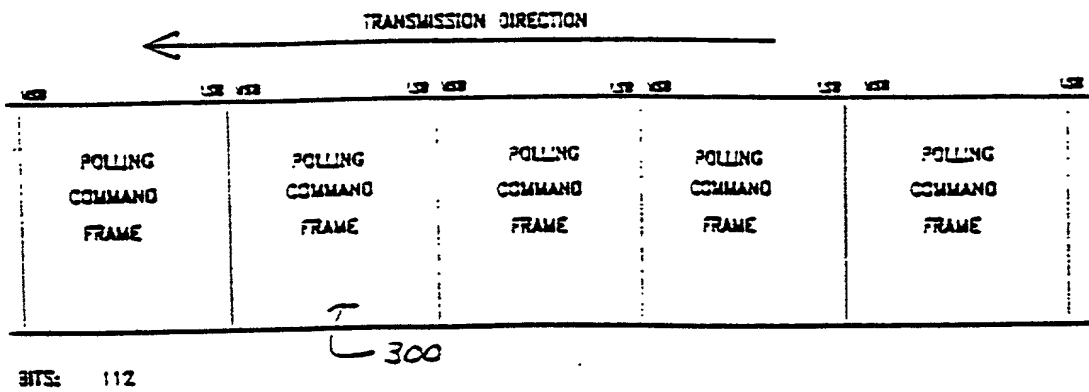


FIGURE 3A

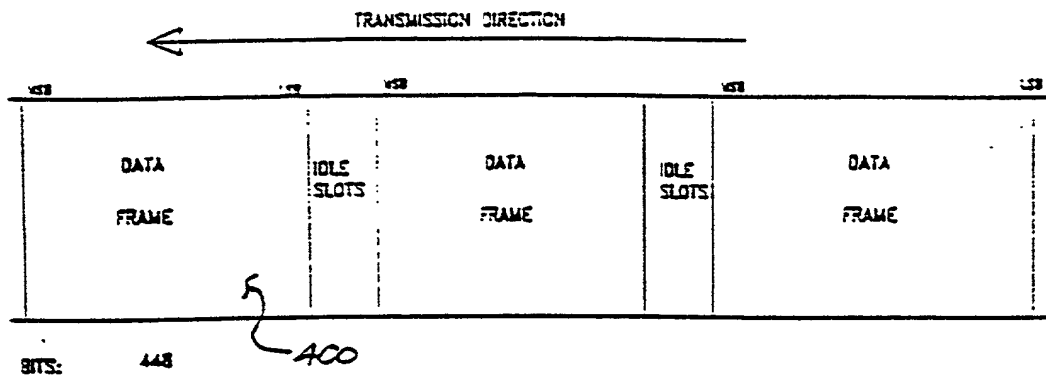


FIGURE 3B

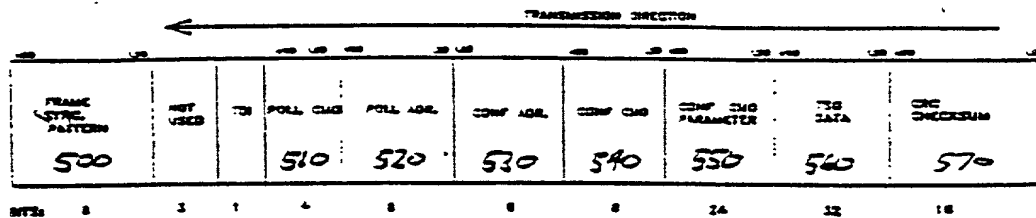


FIGURE 3C

↑

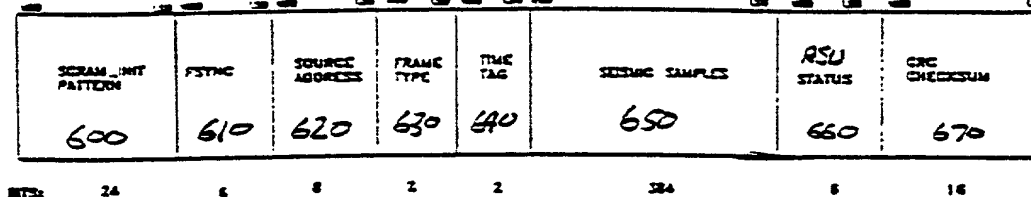


FIGURE 3D

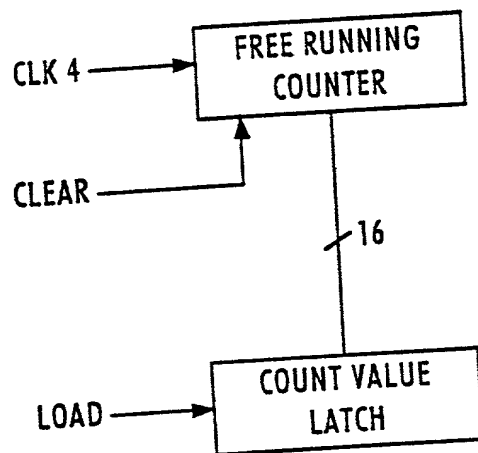


Figure 6A

Poll Sequence

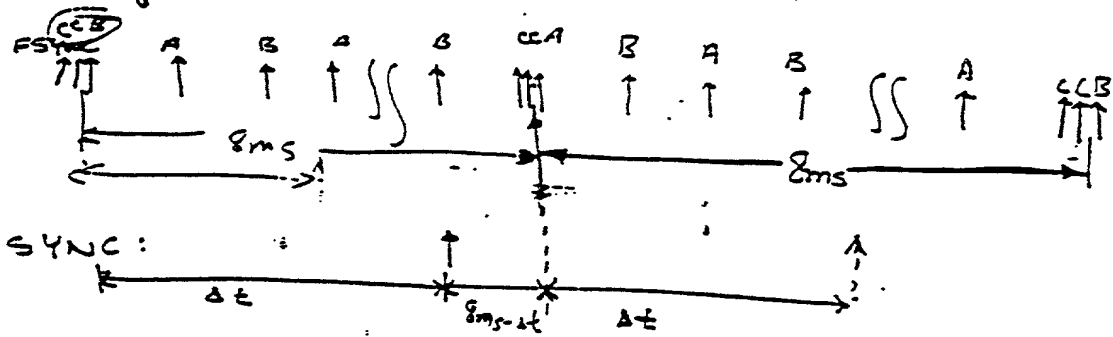


FIGURE 6B

059T60-193E5T60

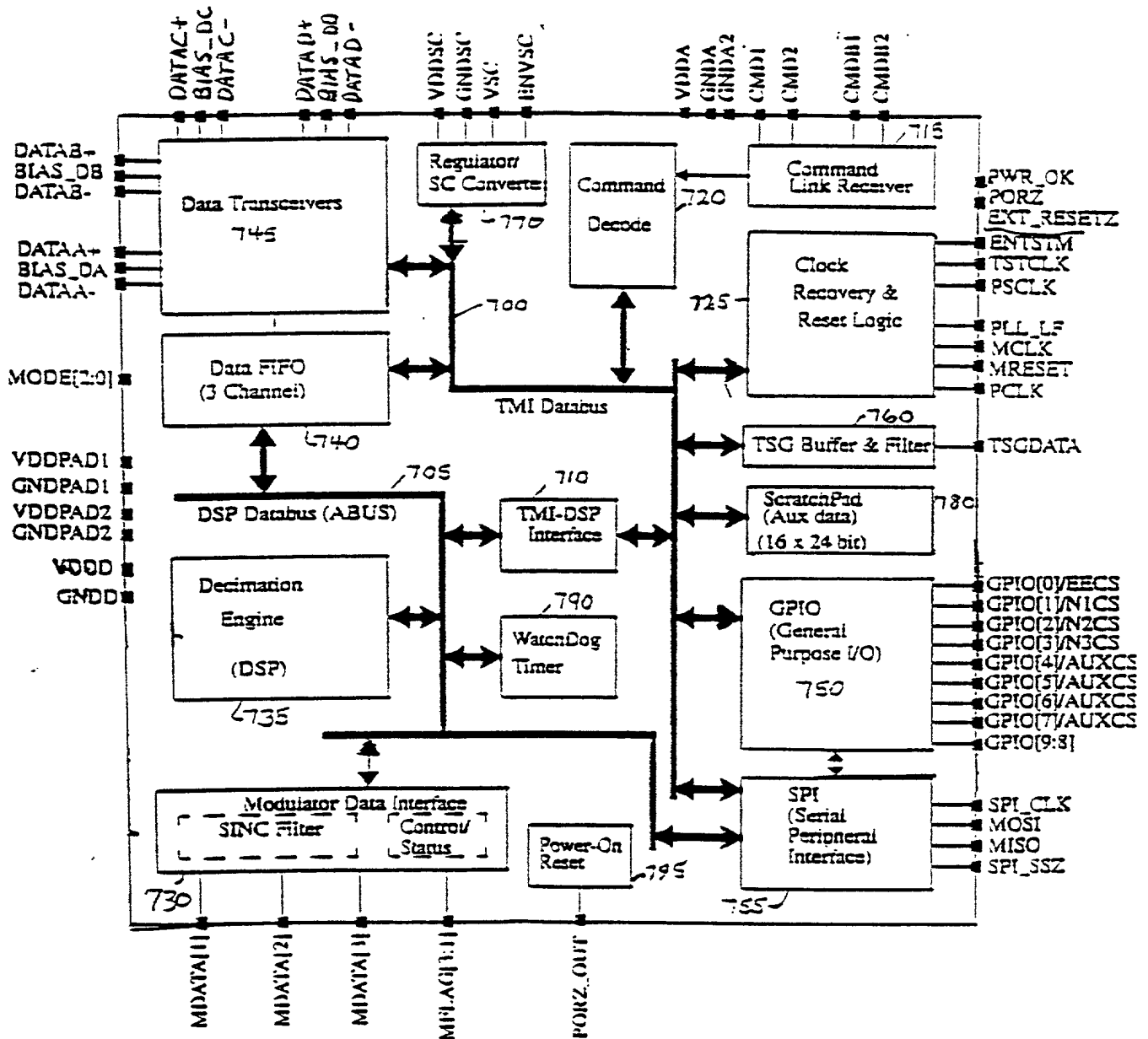


FIGURE 7

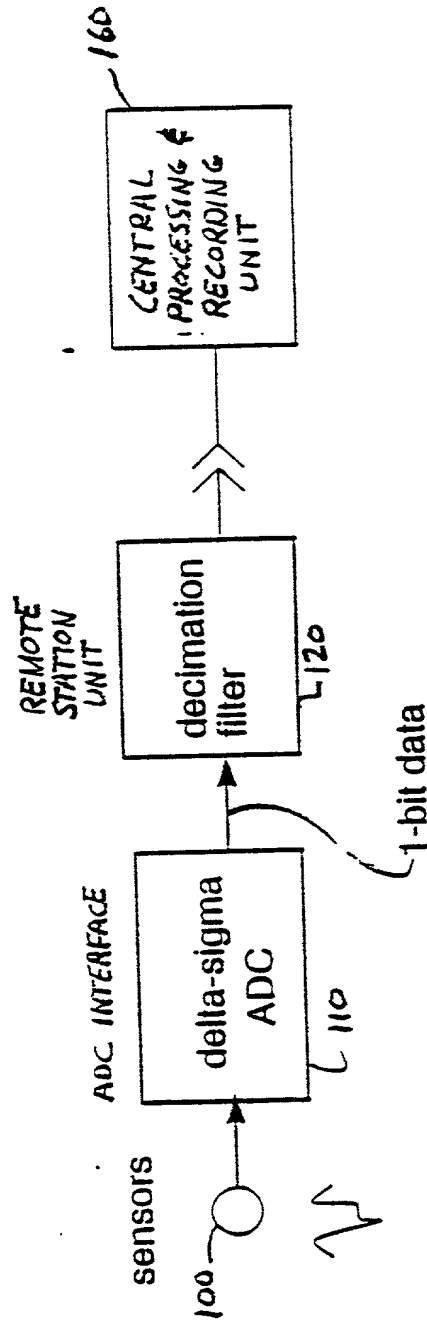


FIGURE 8

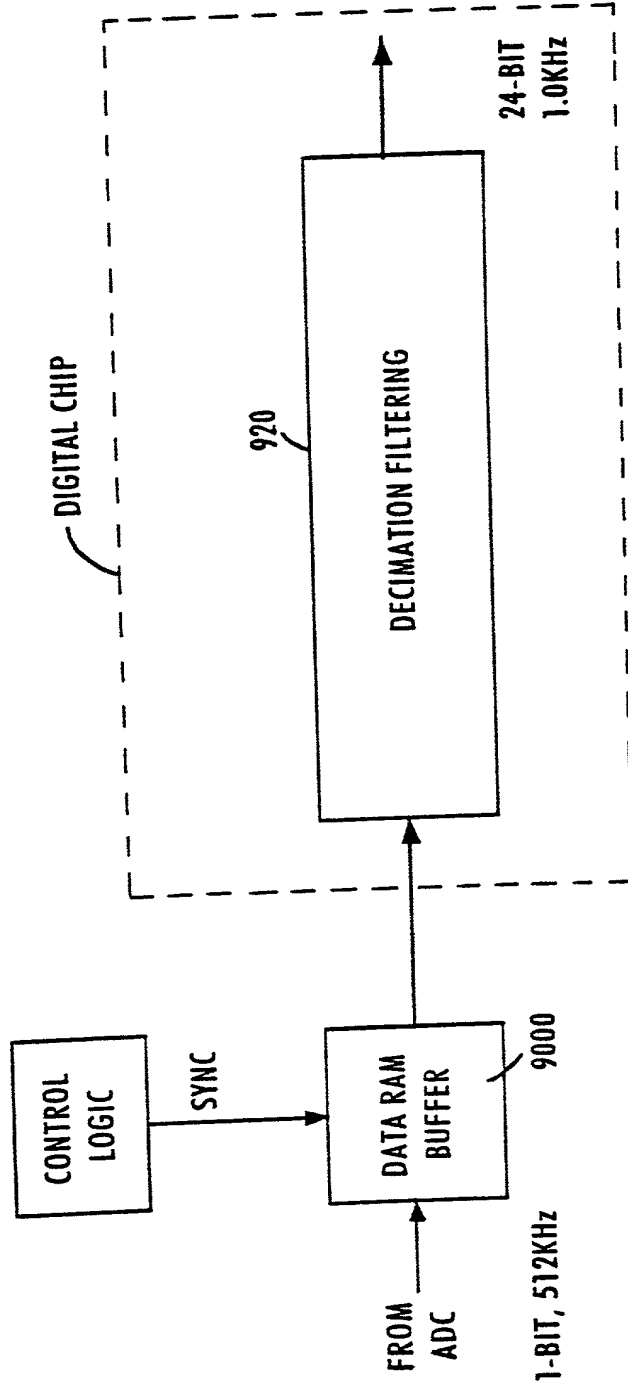


Figure 9 (PRIOR ART)

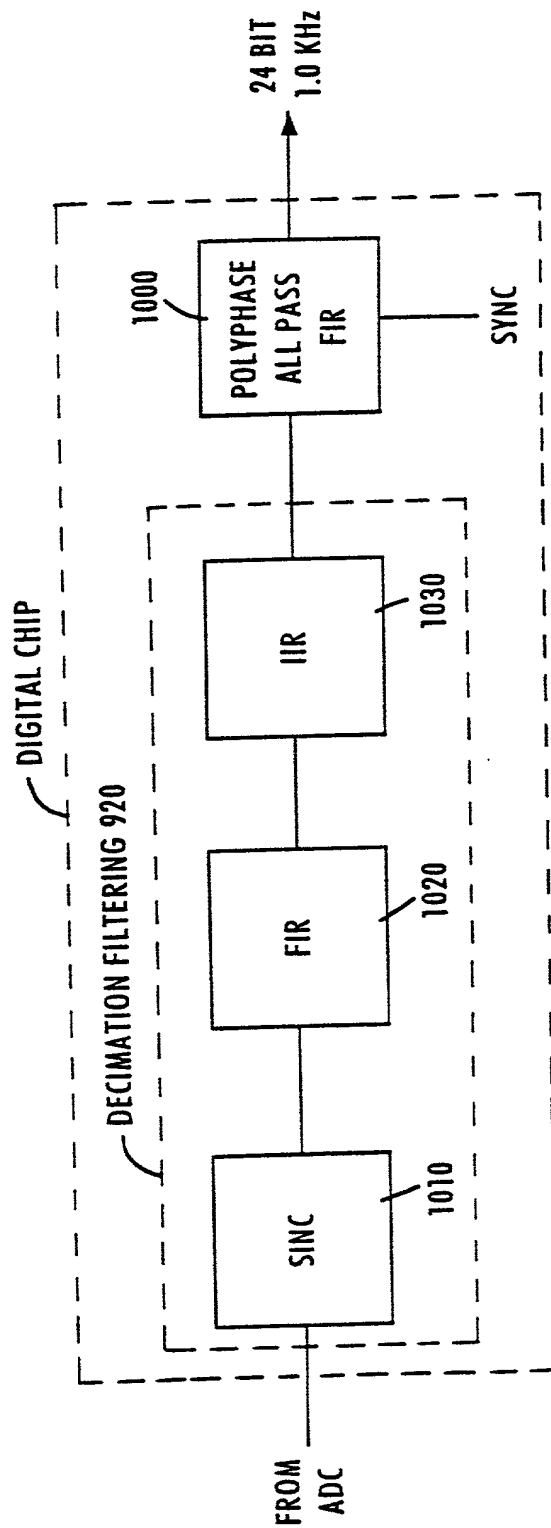


Figure 10

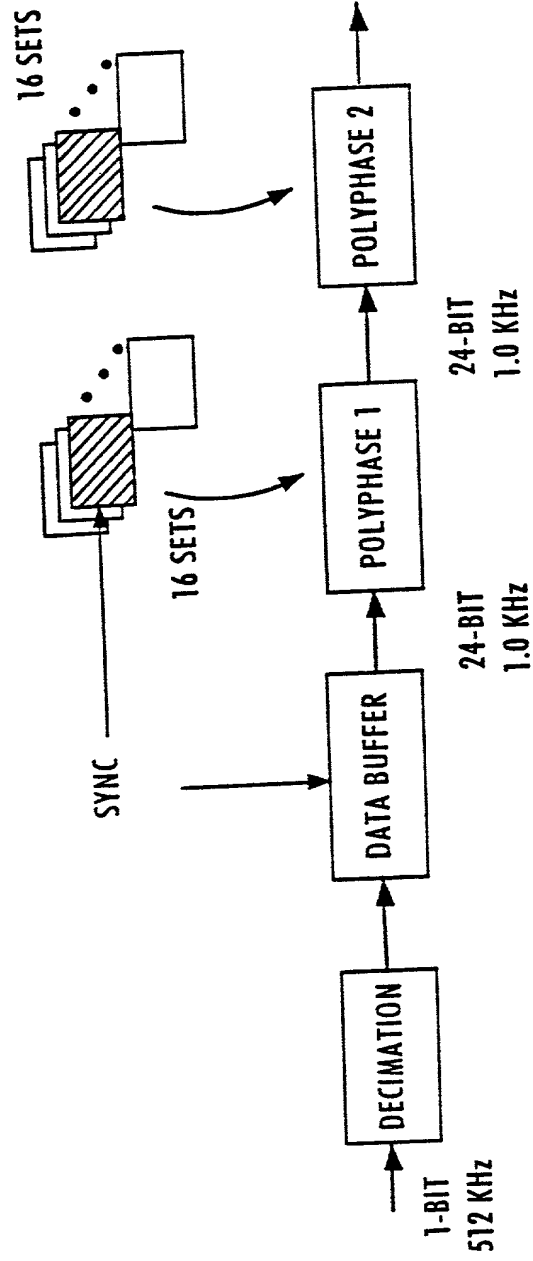


Figure 11

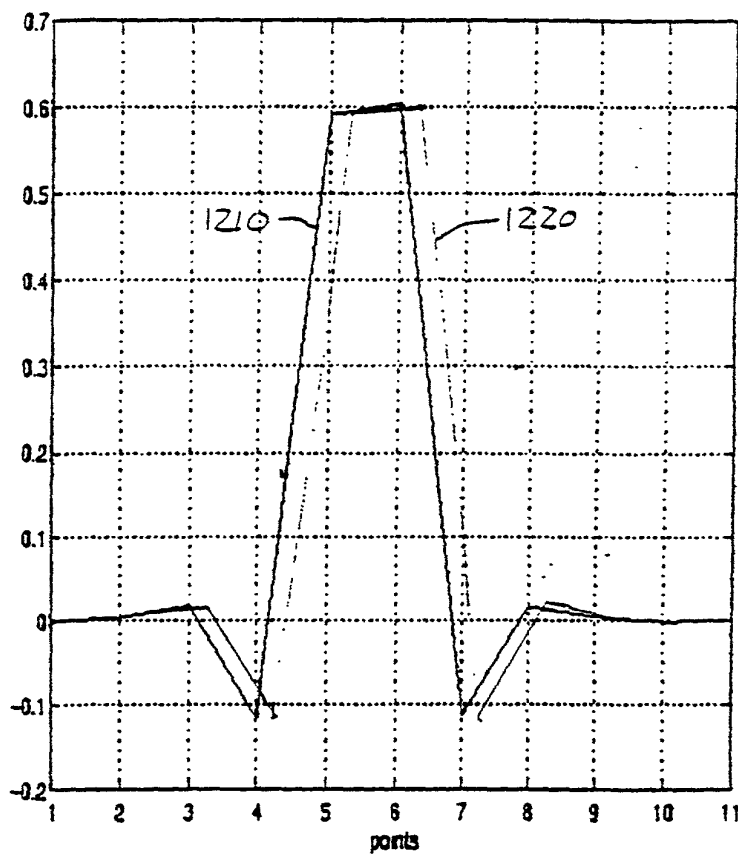
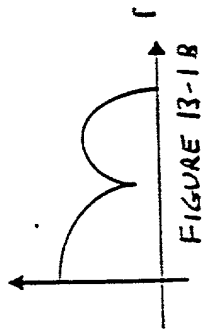
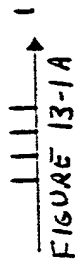


FIGURE 12

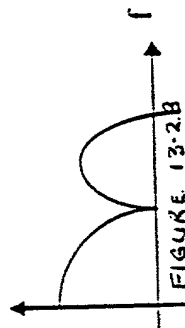
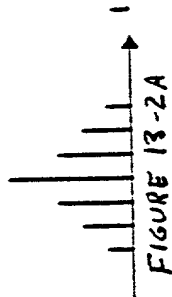
1st order sine filter



$$H(Z) = \frac{(1 - Z^{-4})}{(1 - Z^{-1})}$$

... FIGURE 13-1C

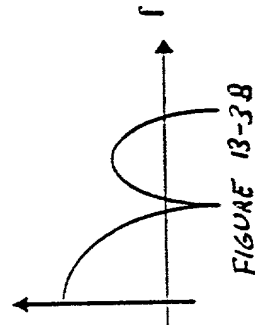
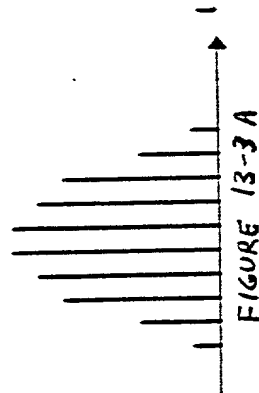
2nd order sine filter



$$H(Z) = \frac{(1 - Z^{-4})^2}{(1 - Z^{-1})^2}$$

FIGURE 13-2C

3rd order sine filter



$$H(Z) = \frac{(1 - Z^{-4})^3}{(1 - Z^{-1})^3}$$

FIGURE 13-3C

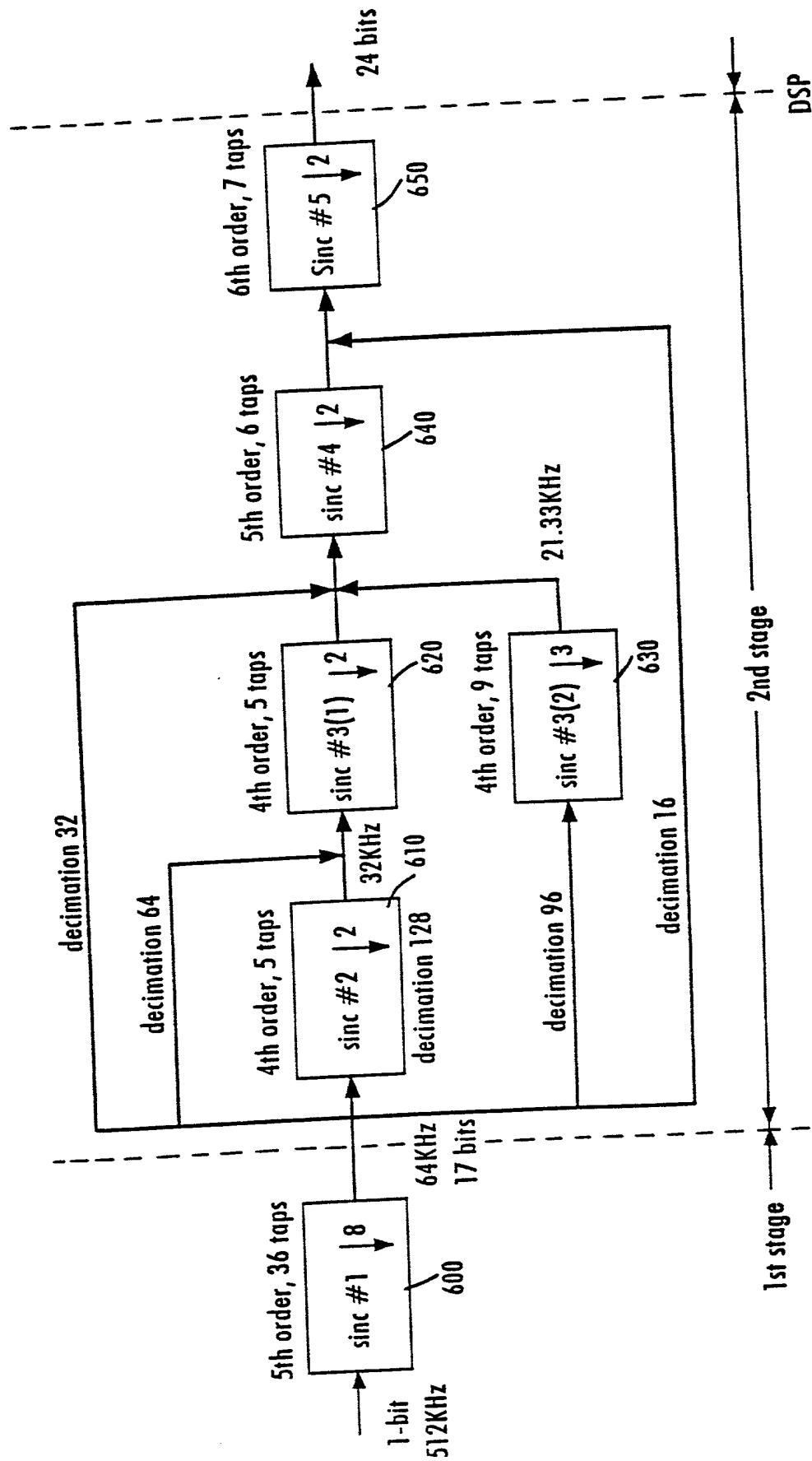


Figure 14

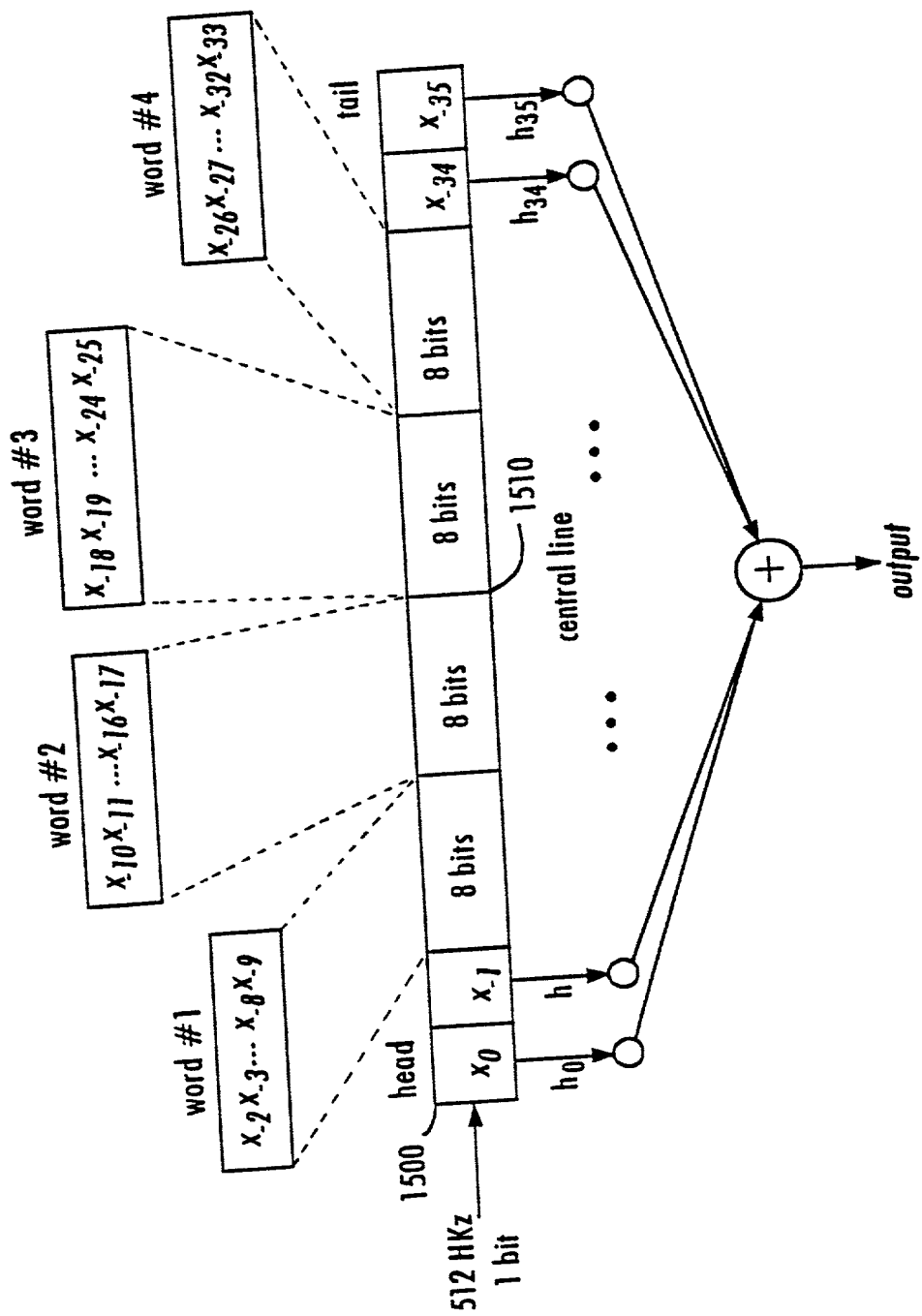


Figure 15

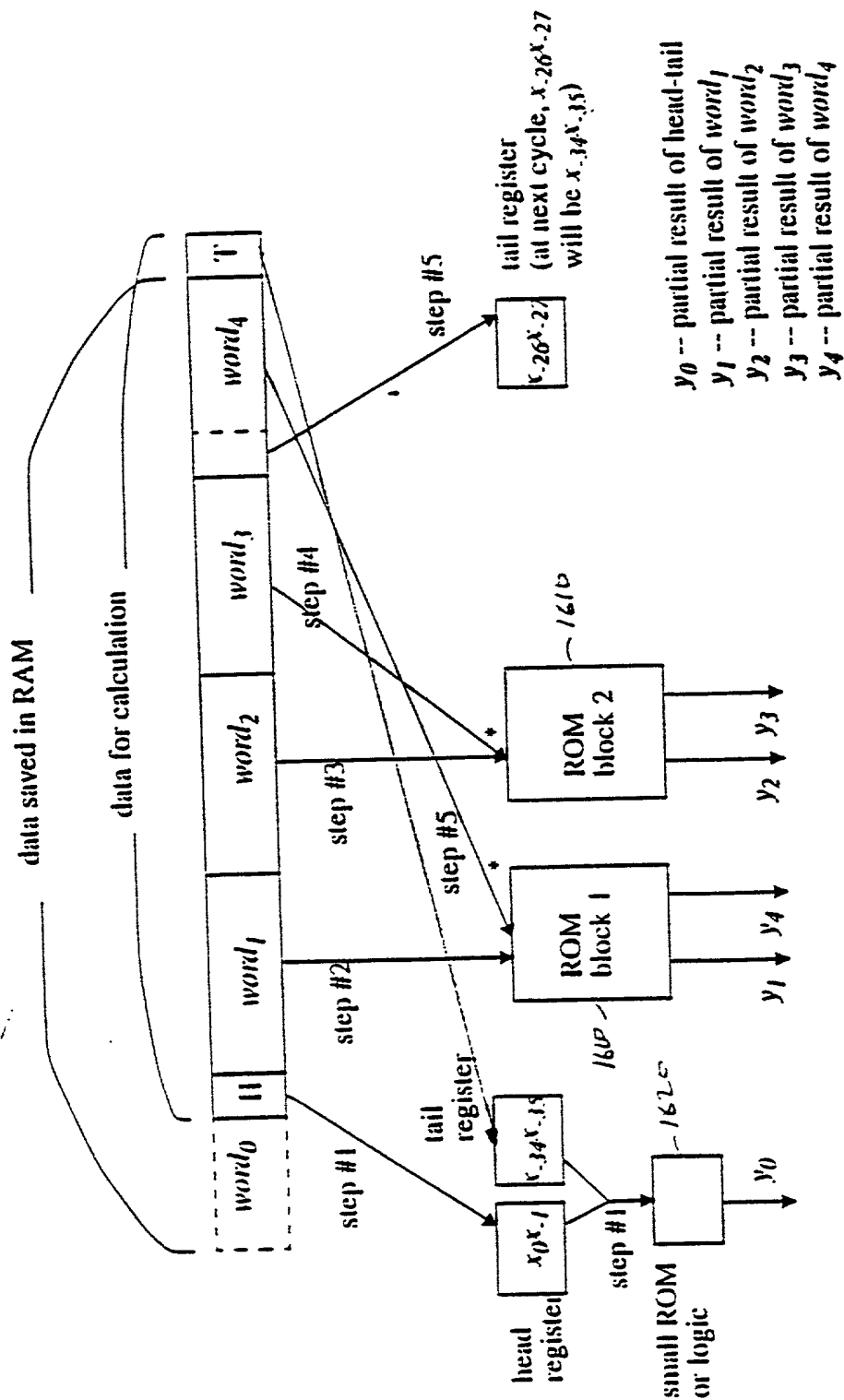


FIGURE 16

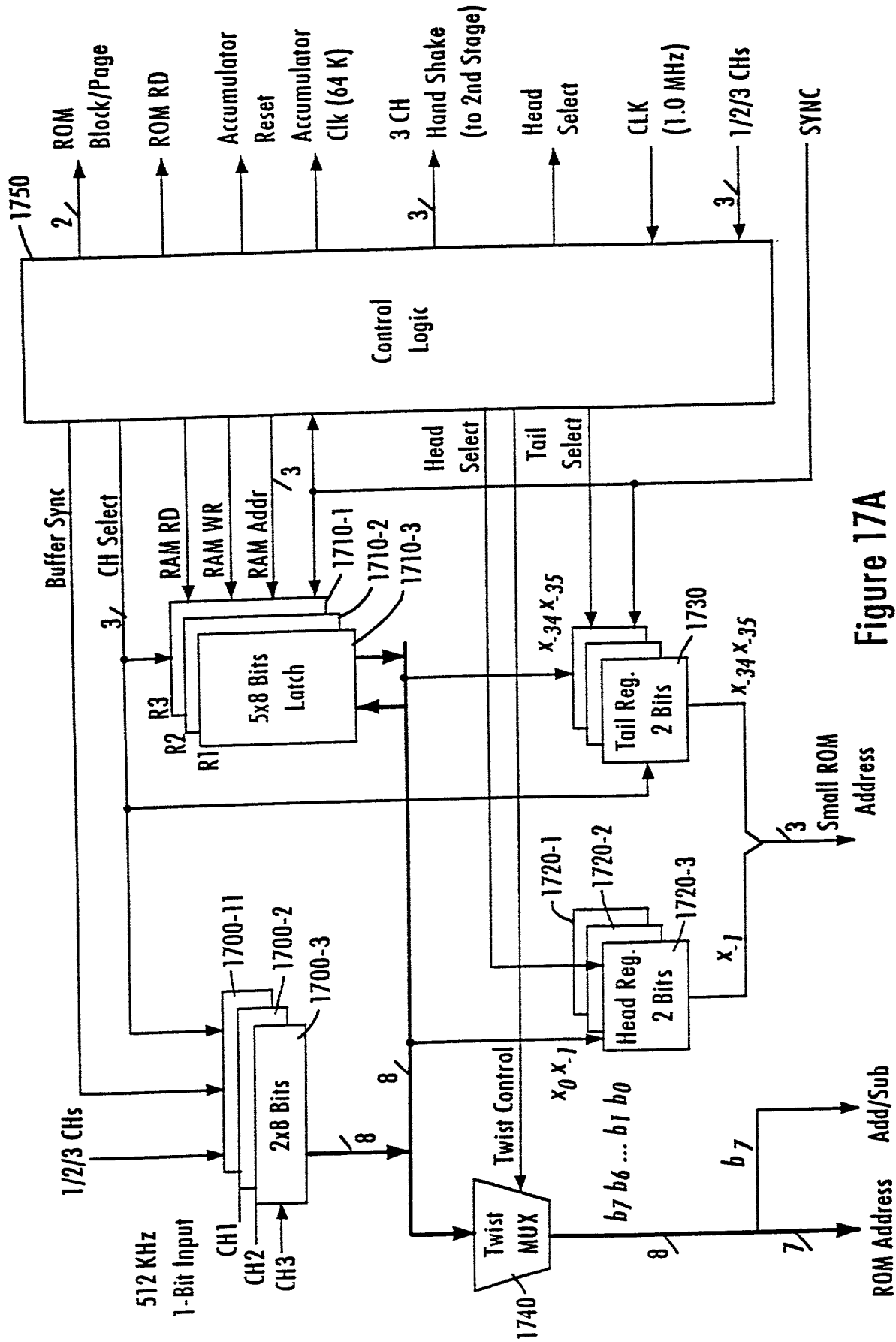


Figure 17A

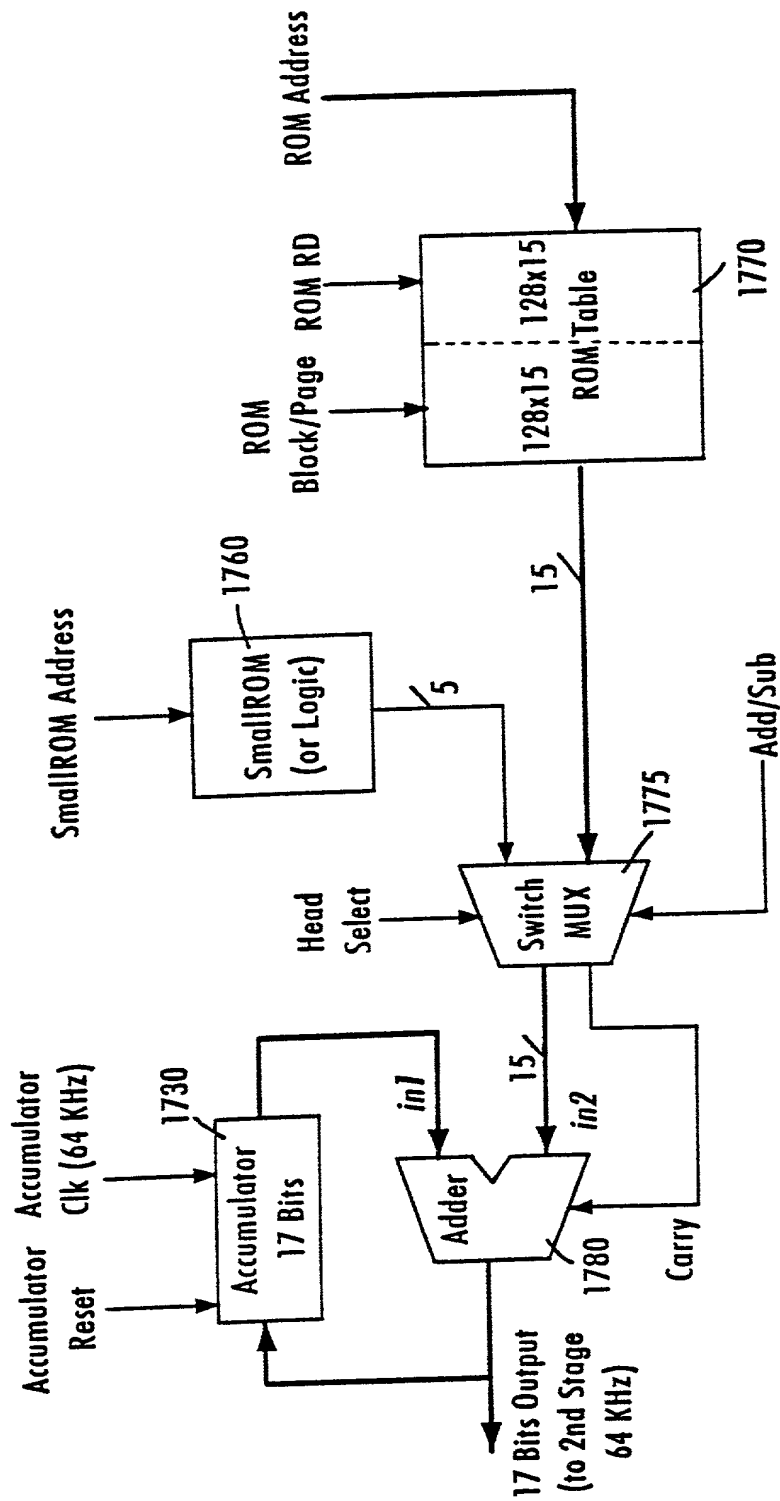


Figure 17B

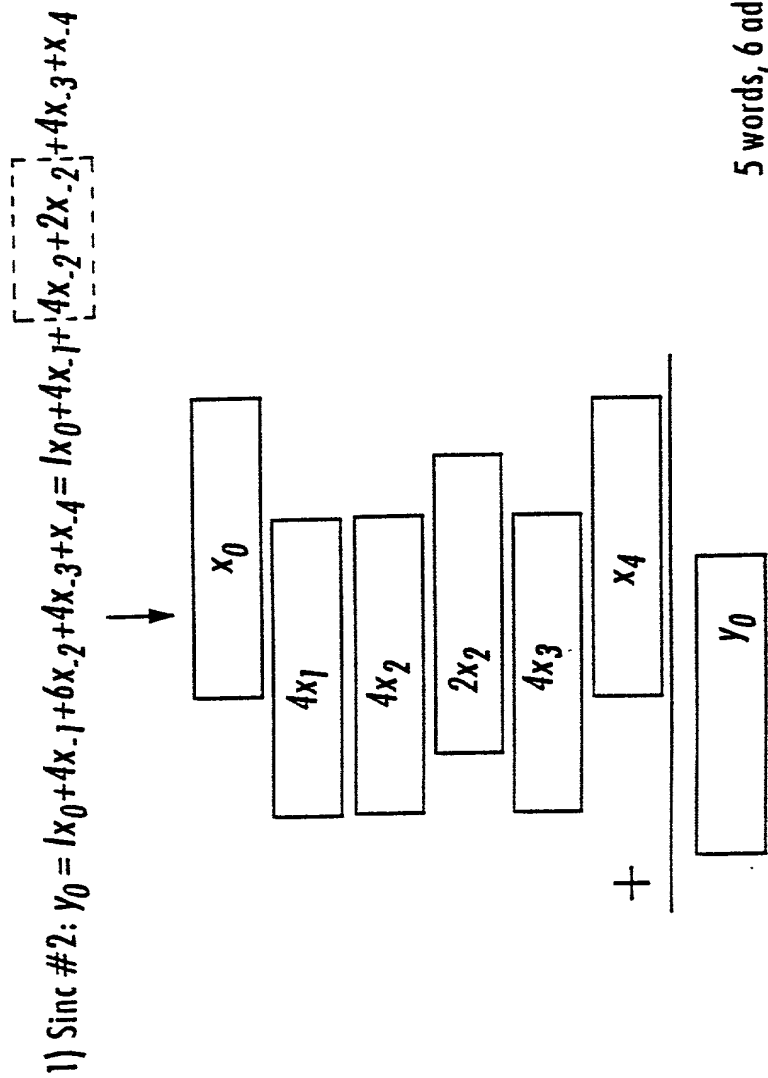


Figure 18A

5 words, 6 additions

Fig. 18B-1 Sinc#3(1) = sinc#2

$$\begin{aligned} \text{Fig. 18B-2 Sinc#3(2): } & x_0 + 4x_{-1} + 10x_{-2} + 16x_{-3} + 19x_{-4} + 16x_{-5} + 10x_{-6} + 4x_{-7} + x_{-8} \\ & = x_0 + 4x_{-1} + \boxed{8x_{-2} + 2x_{-2}} + \boxed{16x_{-3} + 16x_{-3} + 2x_{-4} + x_{-4}} + \boxed{16x_{-4} + 2x_{-5} + 8x_{-6} + 2x_{-6}} + \boxed{4x_{-7} + x_{-8}} \end{aligned}$$

9 words, 13 additions

Fig. 18B-3 Sinc#4: $x_0 + 5x_{-1} + 10x_{-2} + 10x_{-3} + 5x_{-4} + x_{-5}$

$$= x_0 + \boxed{4x_{-1} + x_{-1}} + \boxed{8x_{-2} + 2x_{-2}} + \boxed{8x_{-3} + 2x_{-3}} + \boxed{4x_{-4} + x_{-4}} + x_{-5}$$

6 words, 10 additions

Fig. 18B-4 Sinc#5: $x_0 + 6x_{-1} + 15x_{-2} + 20x_{-3} + 15x_{-4} + 6x_{-5} + x_{-6}$

$$= x_0 + \boxed{4x_{-1} + 2x_{-1}} + \boxed{16x_{-2} - x_{-2}} + \boxed{16x_{-3} + 4x_{-3}} + \boxed{16x_{-4} - x_{-4}} + \boxed{4x_{-5} + 2x_{-5}} + x_{-6}$$

7 words, 12 additions

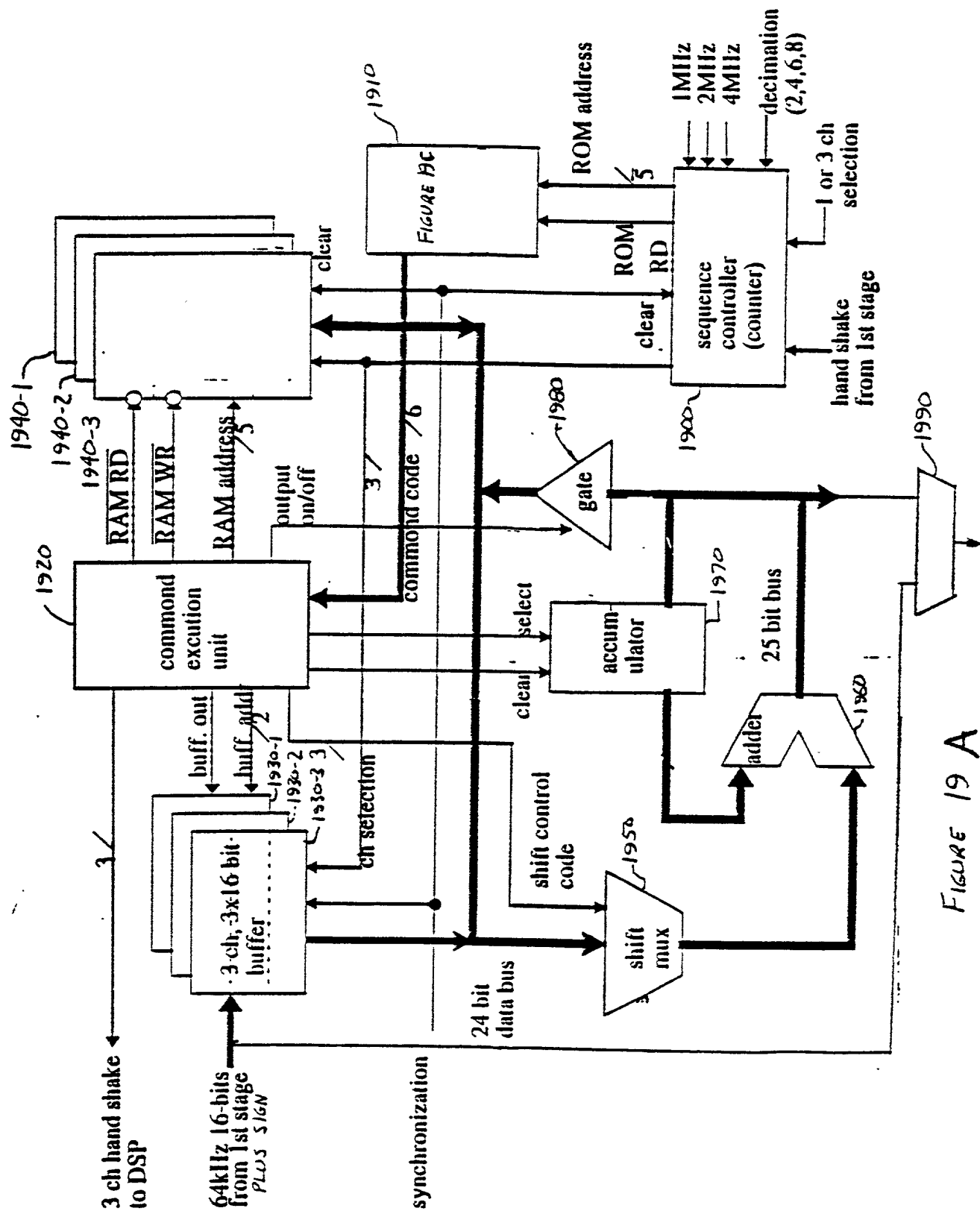


FIGURE 19 A

Programmable Main-Routine and Sub-Routine, Decimate by 8

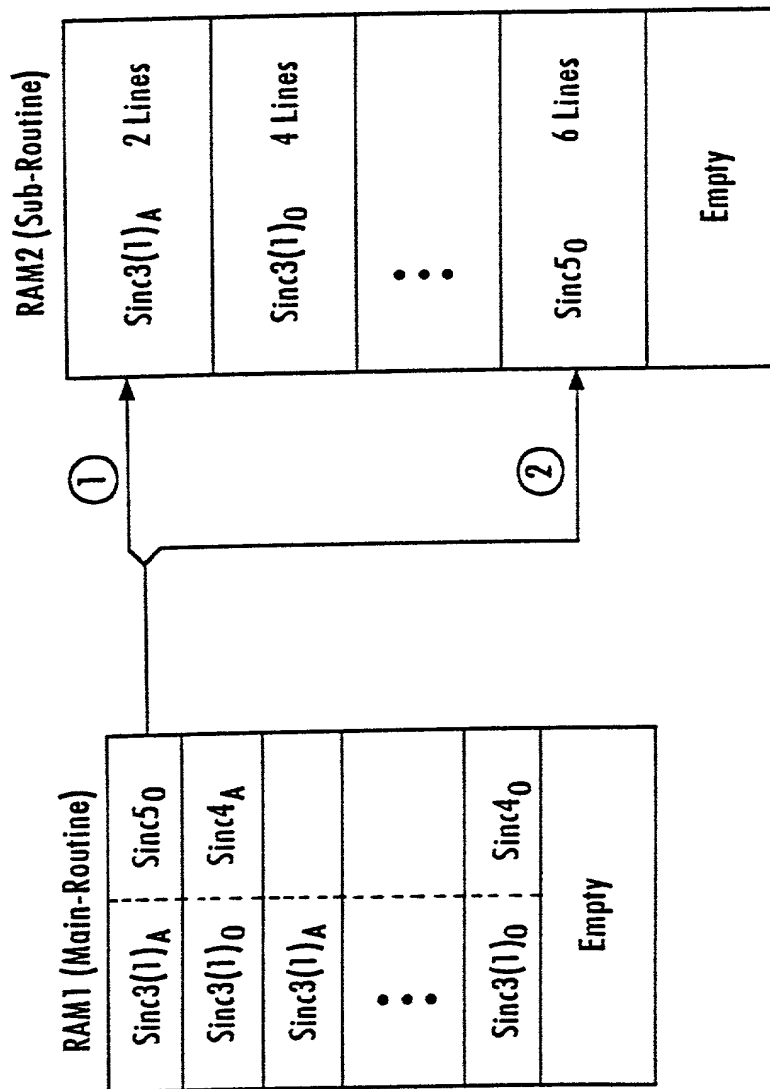


Figure 19B

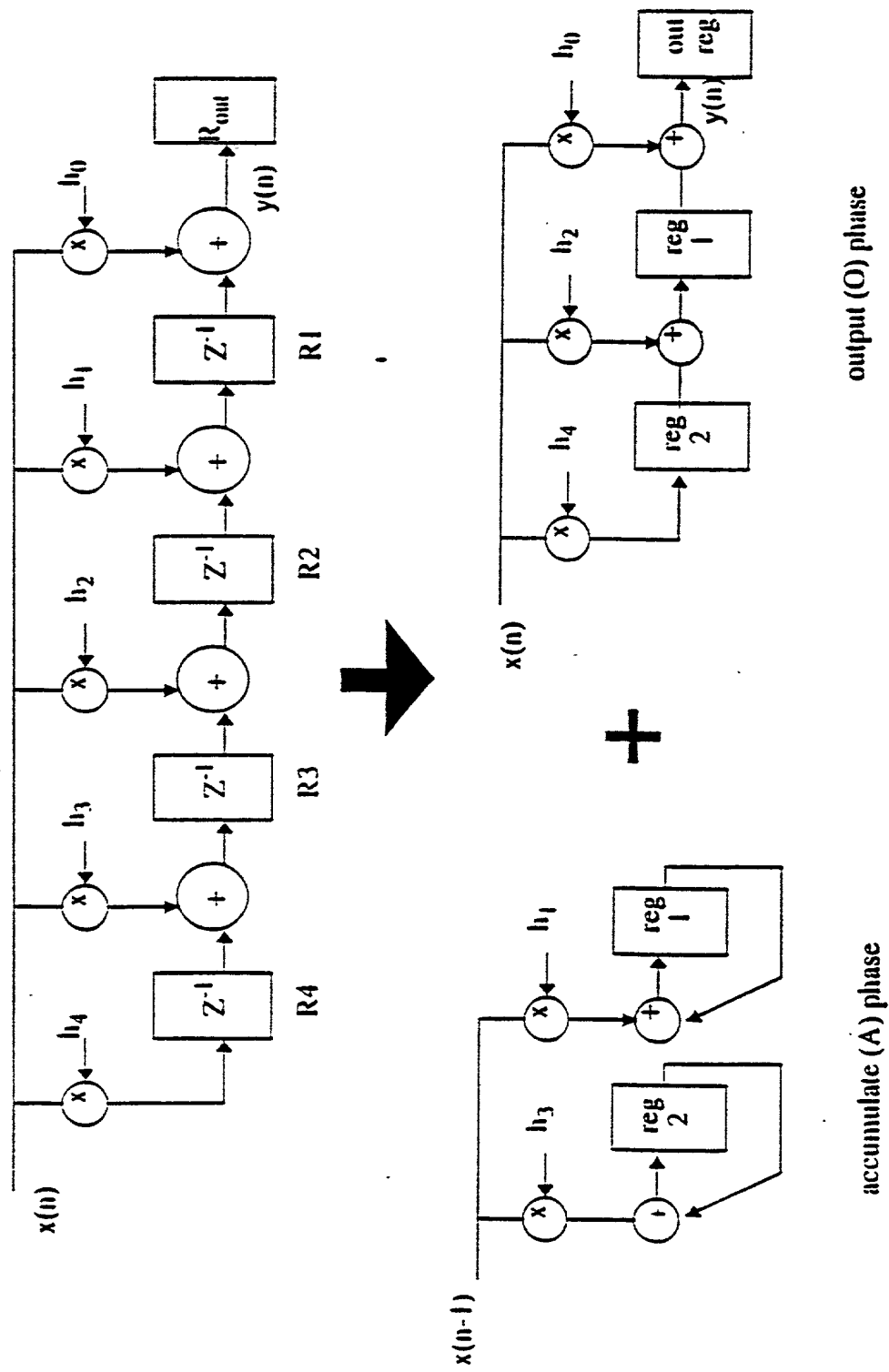


FIGURE 20

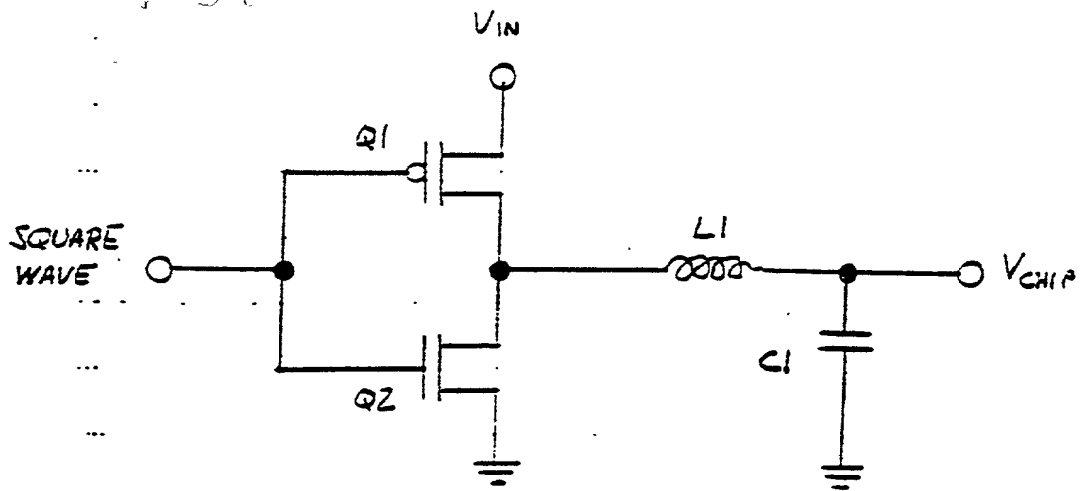


FIGURE 22 (PRIOR ART)

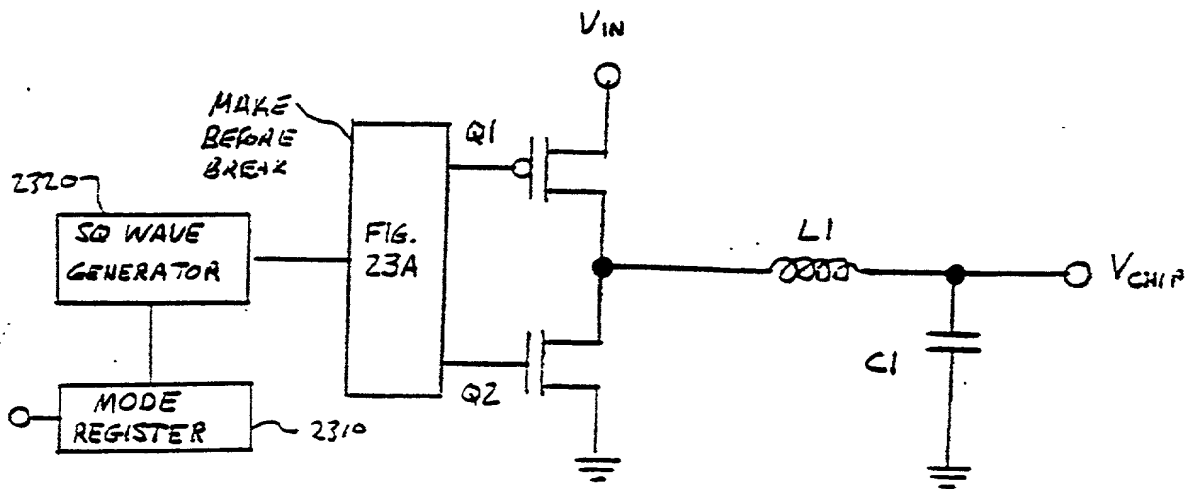


FIGURE 23

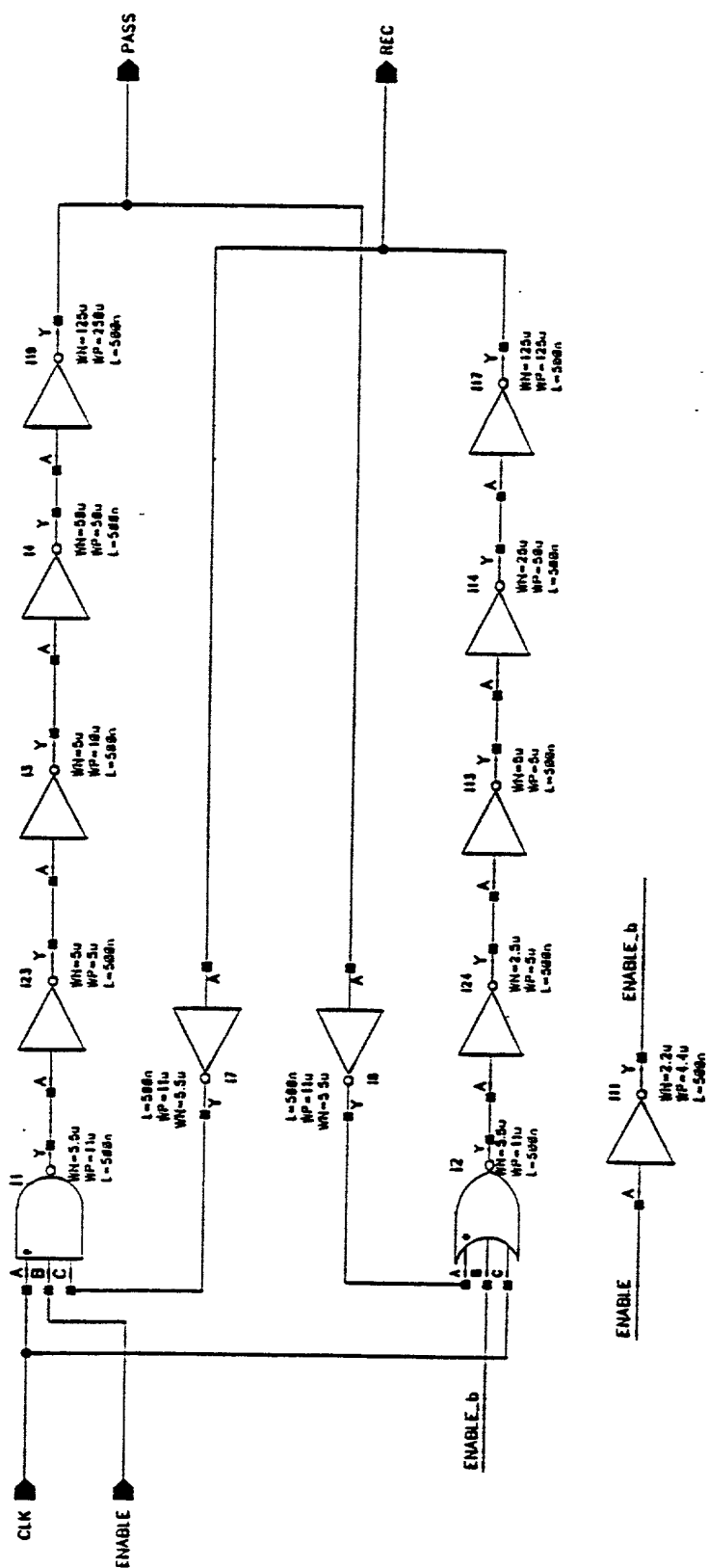


FIGURE 24

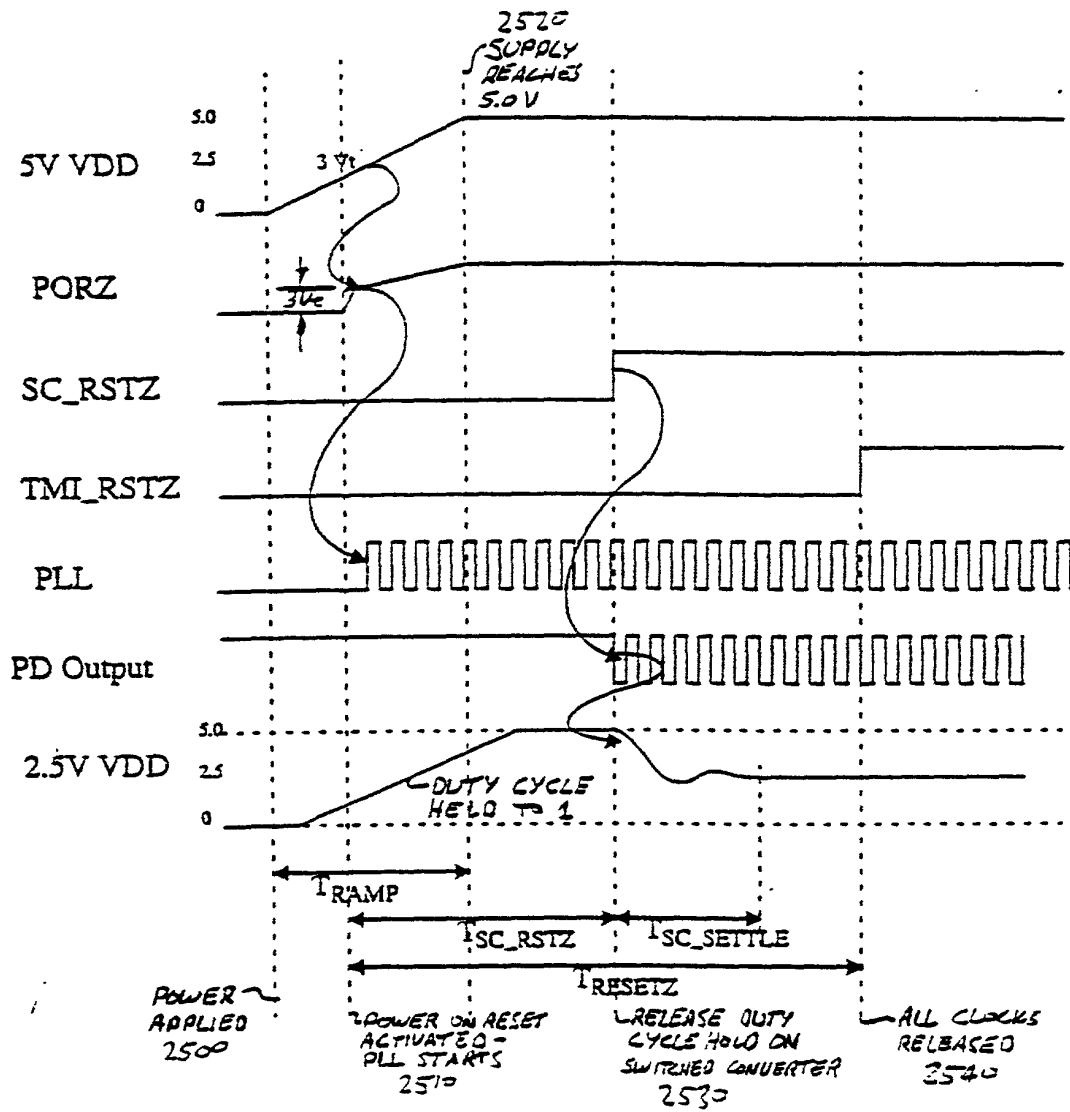


FIGURE 25

FIGURE 26

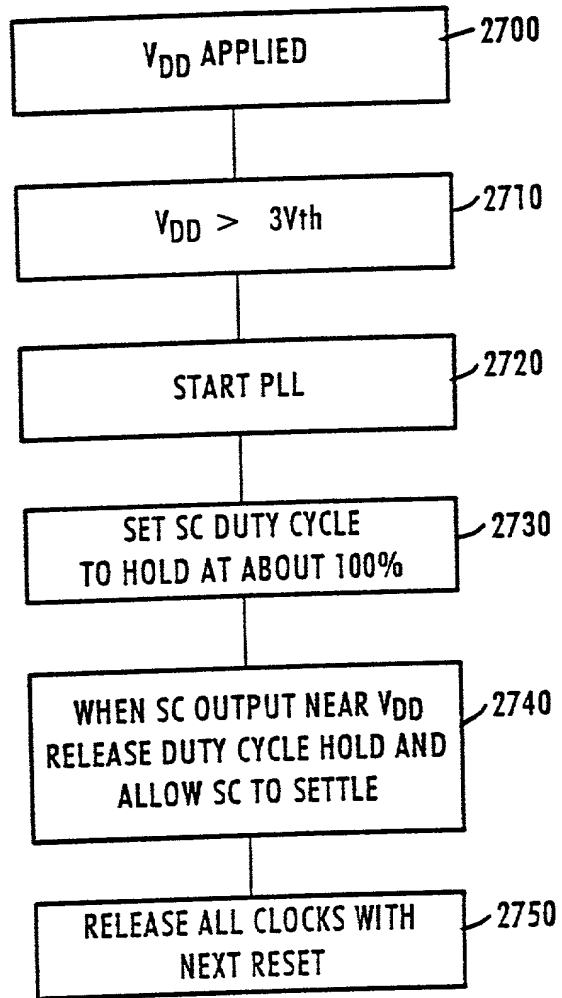


Figure 27

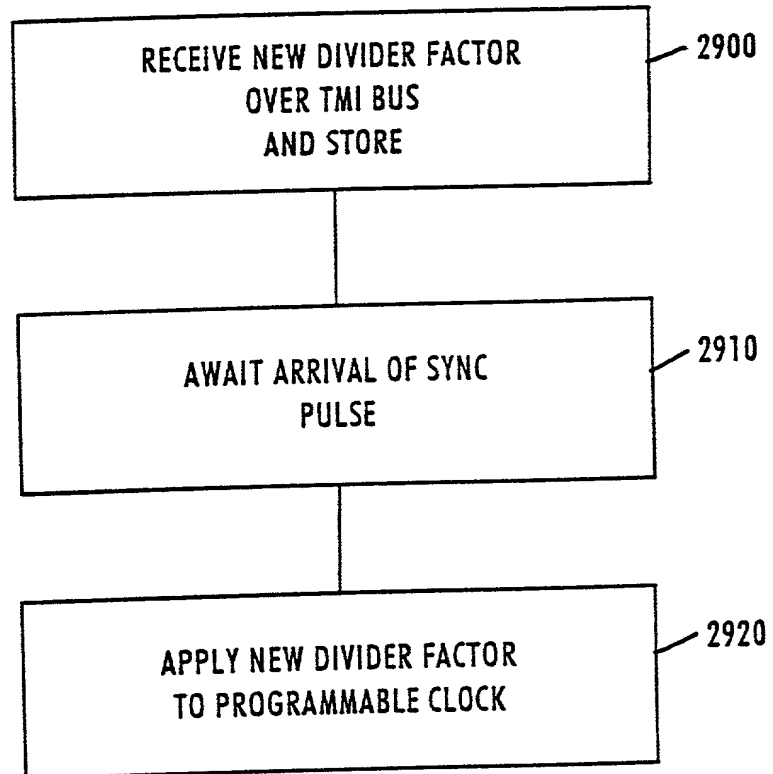


Figure 29

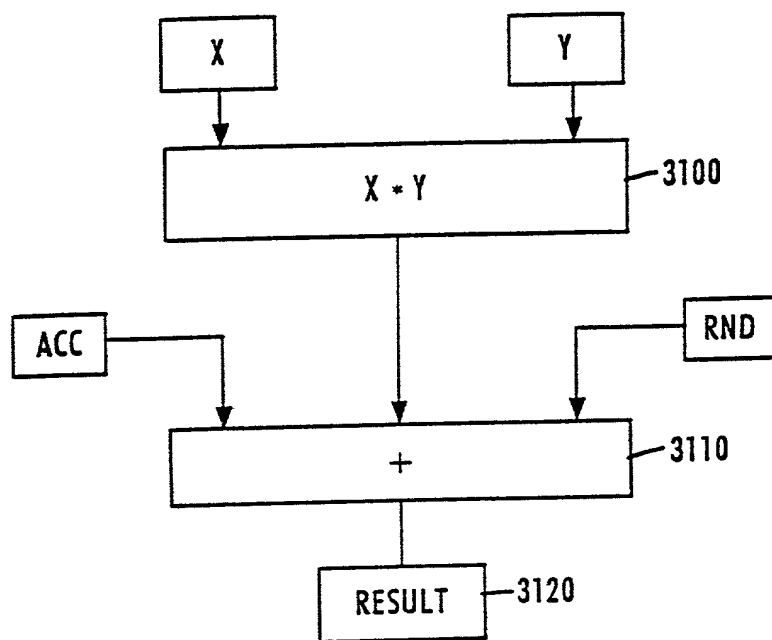


Figure 31

$$X * Y + ACC + RND$$

Figure 30

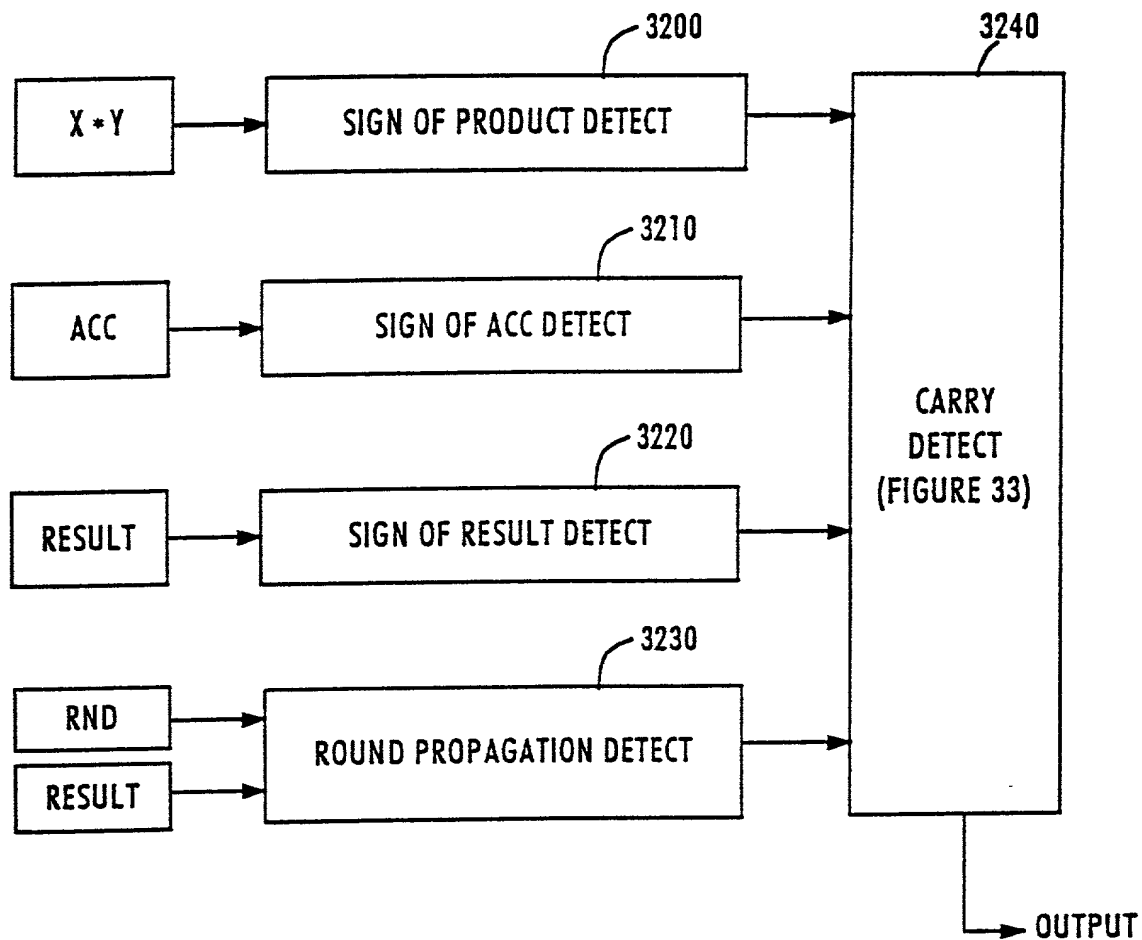


Figure 32

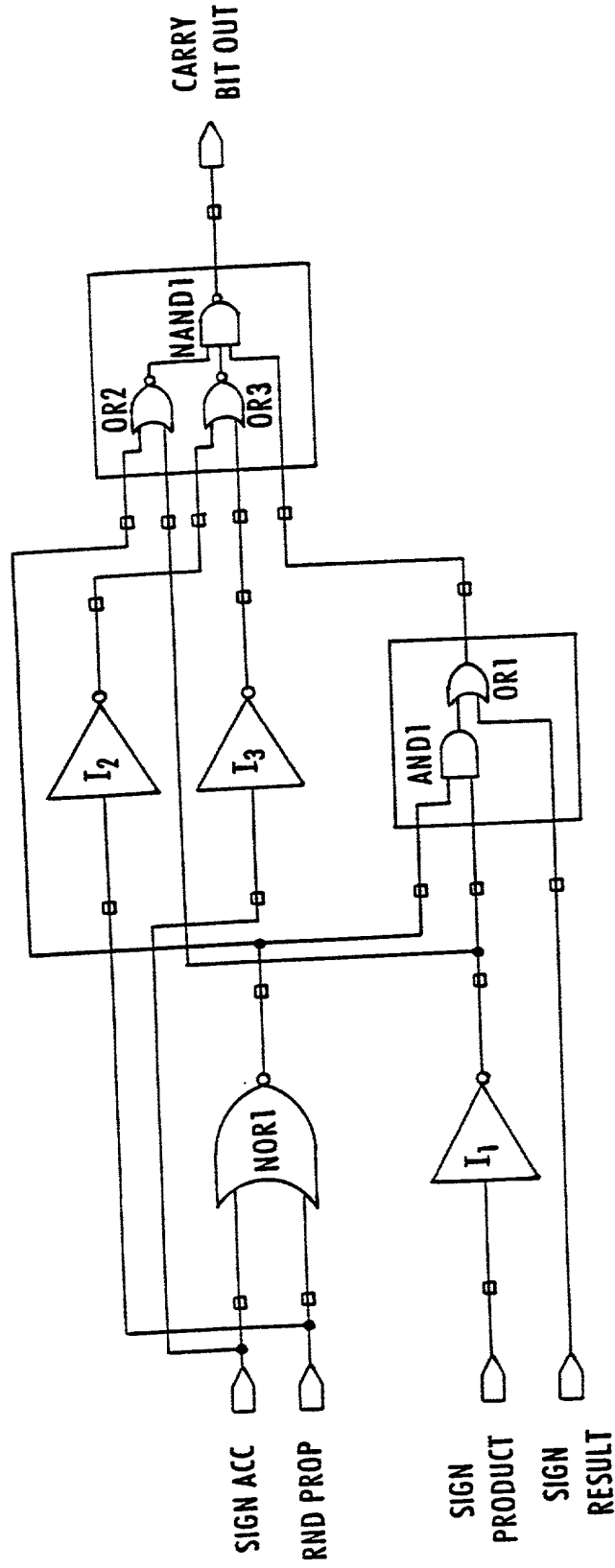


Figure 33